

Flashlink Dense Wavelength Division Multiplexing System

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Accessories enclosed

- Plastic dust caps for fiber optical connectors
- Fiber optic patch cords for interconnection of sub-rack frames
- 110 Ω termination plugs for the Gyda® system controller (optional)
- Cat-5 cables for RS-422 connection to Gyda® (optional)

Revision history

The latest version is always available in pdf-format on our web-site:

<http://www.network-electronics.com/>

Current revision of this document is the uppermost in the table below.

Revision	Replaces	Date (yy.mm.dd)	<u>Change Description</u>
7	6	2007-10-26 AS	New front page and removed old logo.
6	5	2007-10-17 AS	Added Materials Declaration and EFUP
5	4	04.09.13 RS	Added information on 3R re-generation
4	3	04.03.05 RS	Added information on the 32-ch and the 40-ch systems
3	2	03.05.14 RS	Corrected RS-422 interconnection of sub-racks
2	1	02.01.08 RS	622Mbps Telecom version no longer available
1	0	01.07.19 RS	Added specification on optical filters and optical input
0	D	01.05.14 RS	Product release
D	C	01.04.04 RS	Added possibility for 2+2 channel system, separated SDI and Telecom into separate part numbers, added note on power dissipation
C	B	01.03.27 RS	Changed specification
B	A	01.02.15 RS	Corrected specification
A		01.02.04 RS	Preliminary revision

1 General information

1.1 Handling of optical fibers

This product includes fiber optic equipment. Access to the optical signal path is given through the optical connectors (see separate chapter).

Even though a fiber optic cable can look almost the same as an electrical wire, special care must be taken. Inside the cable is a fiber made of glass. Glass has very different physical properties than the copper used in electrical wires.

In practical terms this means that these precautions must be taken:

- Do not bend the fiber too much
- Do not put anything on top of the optical fiber.
- Keep the connectors clean from dust

If a fiber is bent too much, parts of the transmitted light is lost or in worst case the glass is broken. All the datasheets of optical fibers have a point called "minimum bend radius". This means that any bending of the fiber corresponding to a bend radius less than the given value will make the light leak out of the fiber. A typical value is 20 mm to 40 mm (Telcordia standard) for single mode fibers.

You should also avoid putting any heavy items on top of the optical fibers, because this will change the optical properties of the fiber, and contribute to errors in the transmitted signal.

Unless the fiber is damaged, it will regain its optical properties after a bend is straightened out or the items are removed / the squeeze is released.

1.2 Laser safety precautions

Guidelines to limit hazards from laser exposure.

All the available EO units in the flashlink[®] range include a laser. Therefore this note on laser safety should be read thoroughly.

The lasers emit light at wavelengths around 1550 nm. This means that the human eye cannot see the beam, and the blink reflex cannot protect the eye. (The human eye can see light between 400 nm to 700 nm).

A laser beam can be harmful to the human eye (depending on laser power and exposure time), therefore:

!! BE CAREFUL WHEN CONNECTING / DISCONNECTING FIBER PIGTAILS (ENDS).

NEVER LOOK DIRECTLY INTO THE END OF THE FIBER.

NEVER USE MICROSCOPES, MAGNIFYING GLASSES OR EYE LOUPES TO LOOK INTO A FIBER END.

USE LASER SAFETY EYEWEAR BLOCKING LIGHT AT 1310 nm AND AT 1550 nm.

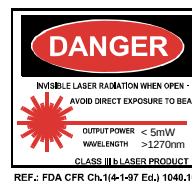
Instruments exist to verify light output power: Power meters, IR-cards etc.

The FR-2RU-10-2 is classified as Class 1 laser product according to EN 60 825-1:94/A11:96, and CFR Ch1(1997) Part 1040.10.

If the front panel is removed, the FR-2RU-10-2 is classified as Class 1 laser product according to EN 60 825-1:94/A11:96, and class IIb according to CFR Ch1(1997) Part 1040.10.

Maximum output power: 17 mW.

Operating wavelengths: 1550 ± 20nm.



1.3 Connector cleaning

Optical connectors should be kept clean at all times. Whenever a connector is disconnected the enclosed protective dust cap should be put on. This protects the ferrule used for fiber alignment and prevents the surface from being scratched or damaged.

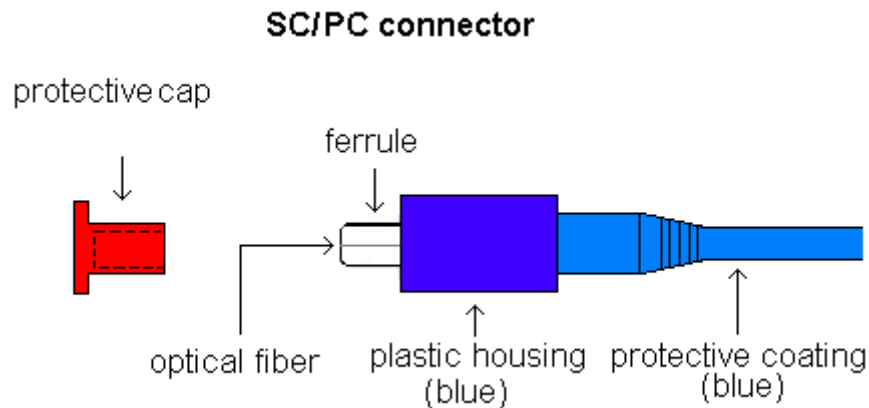


Figure 1.1: The different parts of an SC/PC connector

Cleaning procedure:

If the ferrule is dirty it must be cleaned before re-connection.

If a clean connector is pressed against a dirty connector, both connectors will become dirty resulting in possible degradation of signal quality. Or even worse, you may damage the surface of the connector(s). We recommend that the cleaning procedure is done by using a special cleaning-tape suitable for this purpose, called CleTop (see picture below).



1.4 Power dissipation in the DWDM-system.

Due to the need of very stable laser emission wavelengths, a precise temperature control of the laser cavity is needed. The laser wavelength will drift with changing temperature if the laser is not controlled. This means that the internal temperature of the laser must be kept at a constant level for all operation temperatures.

This is done through the use of a Peltier element placed within the laser package. The function of the Peltier element is to control the temperature in a similar way as a refrigerator. If the ambient temperature increases the Peltier element will cool the inside of the laser package to keep the temperature at a constant level. If the opposite is the case and the ambient temperature decreases, the Peltier element will heat the inside of the package to keep the internal temperature constant. The quantity of heat absorbed or produced is proportional to the current flowing through the contact. In practical terms this means that the current is proportional to the temperature difference between the ambient temperature and the desired temperature within the laser package.

If the ambient temperature is lower than the package temperature, the power dissipated will support the heating process of the device by increasing the ambient temperature. On the other hand, if the ambient temperature is much higher than the desired package temperature (about +22°C) it may cause the laser to malfunction. The current, which is proportional to the temperature difference, implies power dissipation and an increase of the ambient temperature.

This increased ambient temperature will again increase the current through the Peltier element in order to lower the internal package temperature. The increased current will make more power dissipate thereby increasing the ambient temperature, and so on.

To avoid this, proper ventilation of the DWDM-system is needed. In the case of a 16-channel installation a fan must be installed above the uppermost sub-rack frame. Below the lowest sub-rack frame it is recommended to have 1RU of free space to ensure good airflow through the sub-rack frames.

A32-channel system needs 18RU of rack space. Additional rack space needed for ventilation is 1RU at the bottom for cold air intake, 1RU for a fan after 4 frames with an additional 1RU above for cold air intake for the 4 uppermost frames.

1RU	Fan, hot air exhaust
8RU	4x flashlink DWDM frames
1RU	Cold air intake
2RU	flashlink DWDM filter frame
1RU	Fan, hot air exhaust
8RU	4x flashlink DWDM frames
1RU	Cold air intake

1RU	Fan, hot air exhaust
10RU	5x flashlink DWDM frames
1RU	Cold air intake

2RU	flashlink DWDM filter frame
1RU	Fan, hot air exhaust
10RU	5x flashlink DWDM frames
1RU	Cold air intake

The operational temperature for the DWDM-system is 0°-40°C.

1.5 Warranty Statement

The following warranty terms and conditions shall apply to all products manufactured by Network Electronics.

Guarantee

Network Electronics guarantees the good quality of the goods supplied for the period started, or when no period is started for a period of three (3) years as from the date from which they have been put in use, but in no event for more than forty (40) months as from the date of despatch, against all defects or failures which appear therein under proper use, and arise solely from faulty materials or workmanship, is being understood that:

Such guarantee does not cover damage sustained by normal wear or tear or any damage arising in consequence of negligence or improper use and storage.

Such guarantee shall not include any items to which a specific manufacturer's guarantee applies.

Network Electronics liability under this guarantee shall be to supply to the purchaser free of charge, replacements of parts that have proved to be defect. These will be repaired to our costs, provided that we are informed by purchaser in writing, telefax or mail within fourteen days after the defects has been revealed, and the defective goods have been placed at Network Electronics disposal. The defective parts shall become Network Electronics property as soon as they have been replaced.

Product Liability

Network Electronics shall not be liable to damages to persons or property unless the purchaser proves that the loss is due to negligence on the part of Network Electronics or Network Electronics personnel.

Network Electronics shall not be liable for indirect losses of any kind such as loss of trade, loss of profit etc.

In the event that Network Electronics is held liable by a third party for damages arising from product liability the purchaser shall be obliged to become a part to any litigation initiated by a third part against Network Electronics.

2 Interconnection of the DWDM-systems

The interconnection of each sub-rack is shown below, and this will apply to all sub-racks and systems. The optical filter is marked with the respective DWDM wavelengths. The optical port *must be* connected to the corresponding wavelength on the channel cards, otherwise the optical filter will suppress the information running on that channel.

The ports are as follows:

C= Common port

1-4 = Channel wavelengths for sub-rack channels 1-4

U= Upgrade port

The GYDA system controller-card, is an optional card, and not part of the standard product.

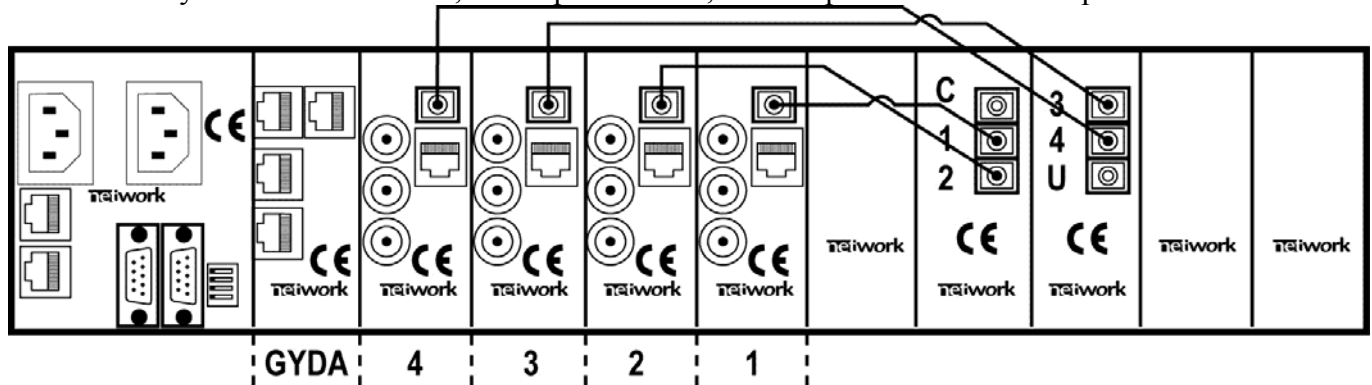


Figure 2.1: Optical interconnection of a sub-rack in the DWDM system

In the different systems described in this chapter, we only show how to connect the different sub-racks together. The interconnection of each sub-rack is omitted in these drawings, since the patching is the same as in figure 2.1 for all sub-racks regardless of whether it is an Rx or Tx sub-rack frame.

Apply signals to the different channels and connect the power cords.

The system will need up to two minutes to stabilise after the power has been switched on.

2.1 4-channel systems

A 4-channel system consists of two sub-racks of 2RU each. One sub-rack at the transmitter side and one sub-rack on the receiver side. A feature of the system is that by swapping two laser cards with the corresponding receiver cards in the corresponding sub-rack frame, a bi-directional system with 2 channels in each direction is possible.

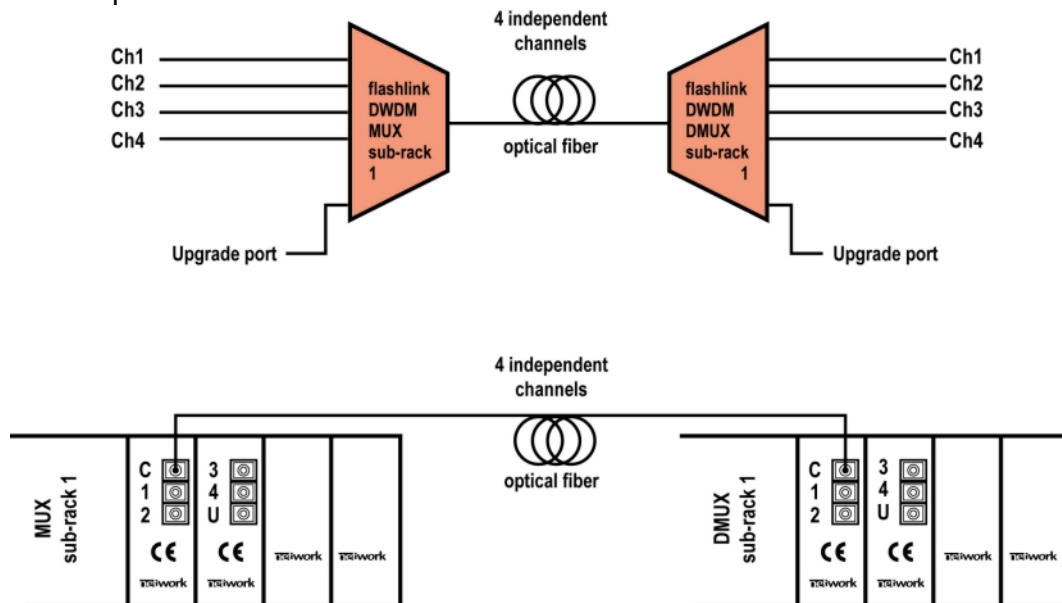


Figure 2.2: 4-channel unidirectional DWDM system, description of system and connections of the sub-racks.

2.2 8-channel systems

Expanding the 4-channel system with another sub-rack frame makes an 8-channel DWDM system able to transmit 8 channels in one direction, or 4 channels in each direction. Examples of how these systems can be configured, are shown in figures 2.3-2.5.

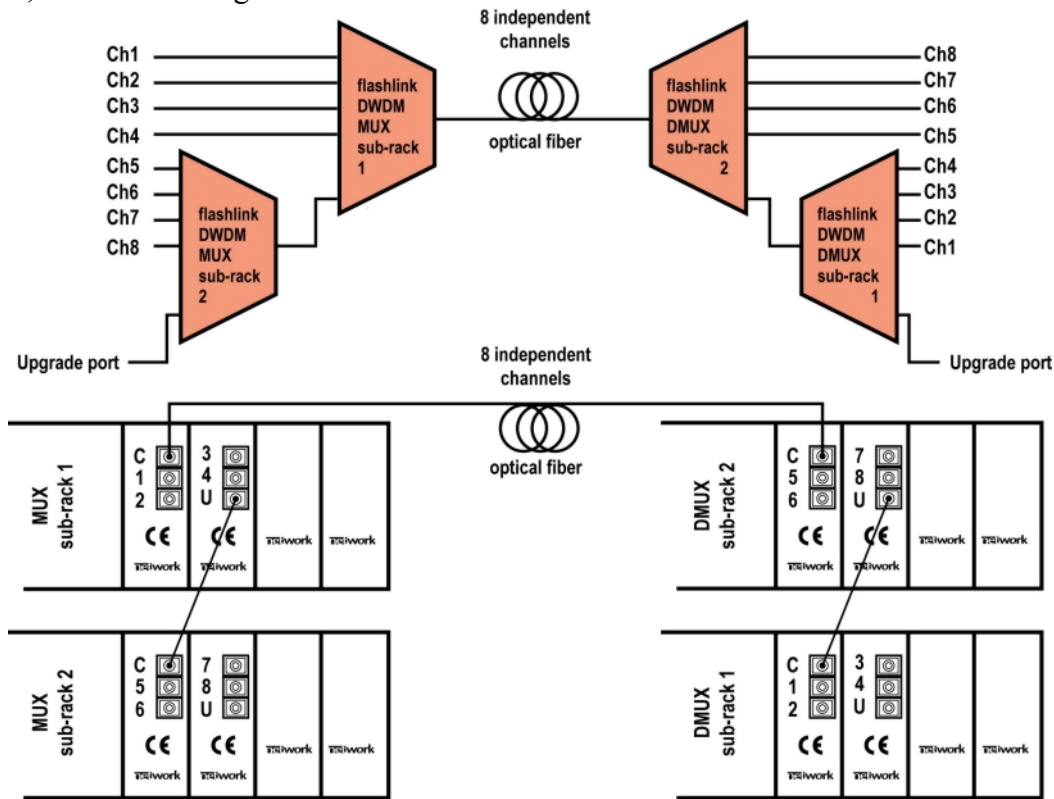


Figure 2.3: 8-channel unidirectional DWDM system, description of system and connections of the sub-racks 1 and 2. Notice the reverse order of the frames at the two ends of the fiber.

A 4-channel bi-directional system can be configured in two different ways. One can either use the red/blue-split filter module to combine sub-racks 1 and 3 (or sub-racks 2 and 3) to have a group of 4 channels going in each direction at different colour bands. This is the preferred solution because it is least sensitive to channel cross talk. As an alternative, a solution with two cascaded sub-racks can be used, sub-racks 1 and 2 is the most cost efficient combination here, but this combination is more sensitive to channel cross talk than the solution using sub-rack 3.

In figure 2.4 we also see the connector module for the red/blue-split module dividing the used wavelengths into two groups, which is placed within sub-rack 3. This filter is used for two reasons. The first reason is to reduce the overall insertion loss. The second reason is that in a bi-directional system, some prefer to split the channels into two groups. The blue wavelengths in one direction, and the red wavelengths in the other direction.

The ports are as follows:

C= Common port

B= Blue wavelengths (the shortest wavelengths, to sub-racks 3 and 4)

R= Red wavelengths (the longest wavelengths, to sub-racks 1 and 2)

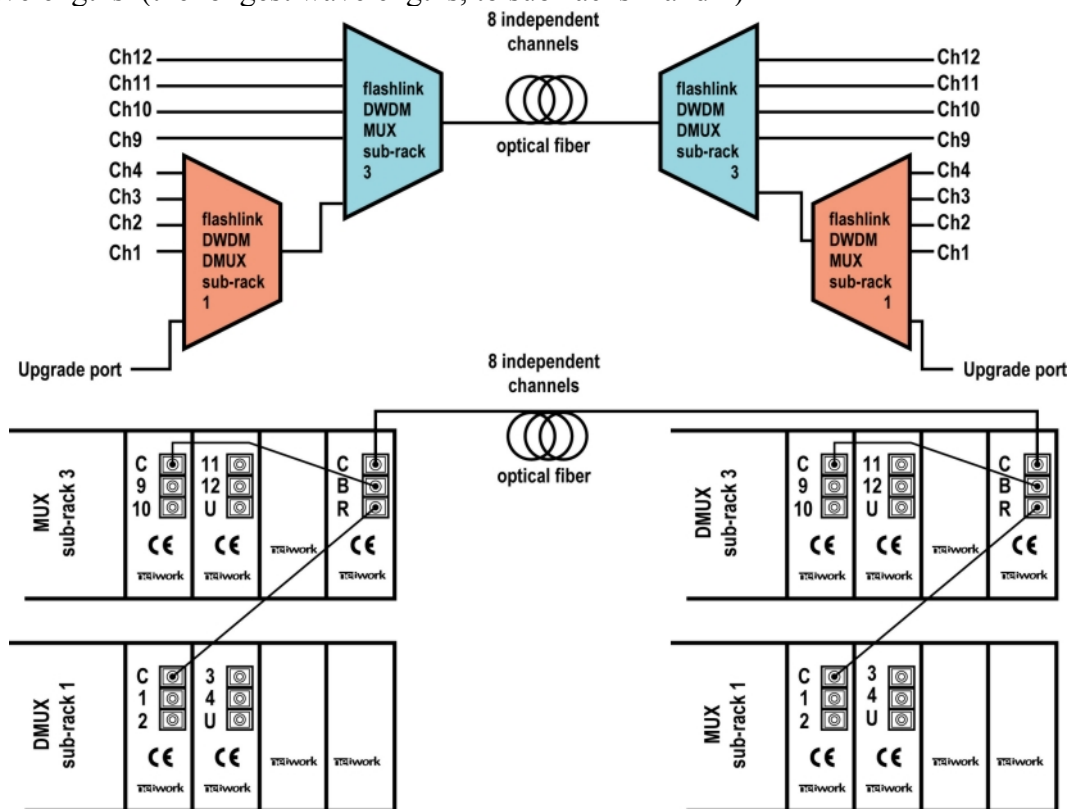


Figure 2.4: 4-channel bi-directional DWDM system, description of system and connections of the sub-racks 1 and 3.

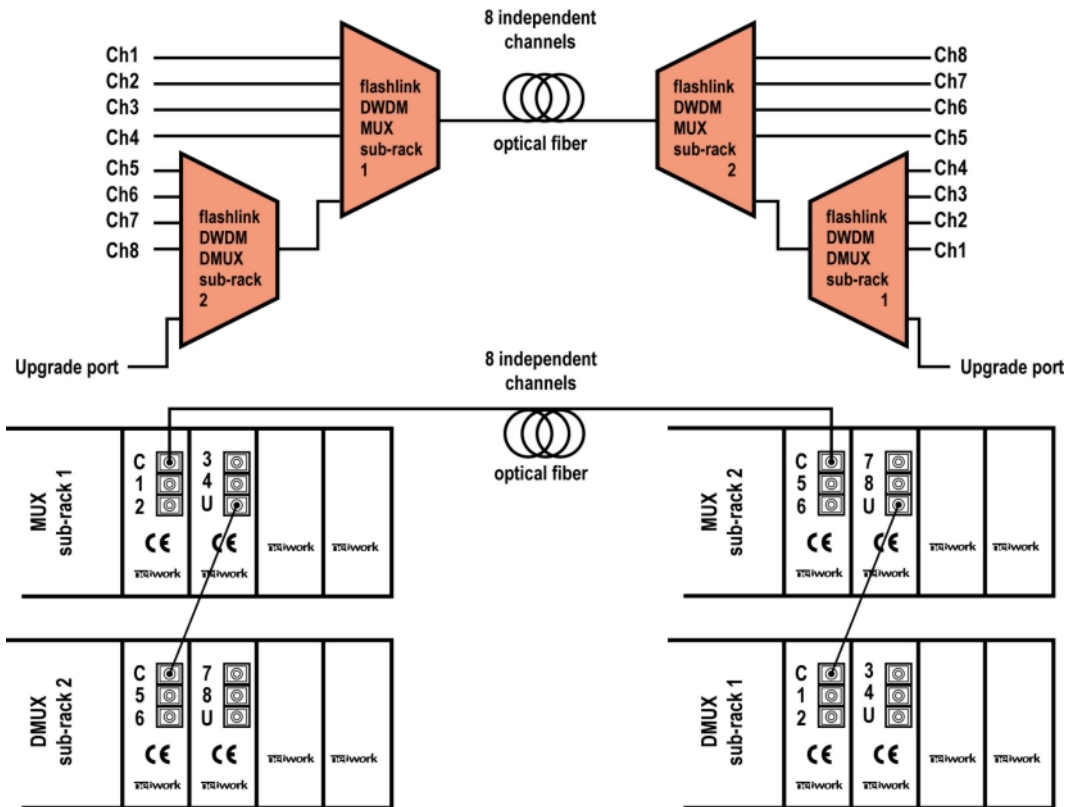


Figure 2.5: 4-channel bi-directional DWDM system, description of system and connections of the sub-racks 1 and 2.

2.3 12-channel systems

Adding another sub-rack frame to the 8-channel system makes a 12-channel system capable of transmitting 12 independent channels in one direction, or 4 channels in one direction and 8 channels in the opposite direction. All channels are transmitted through the same fiber. Figures 2.6 and 2.7 shows examples of a 12-channel unidirectional system, and a bi-directional 8+4-channel system.

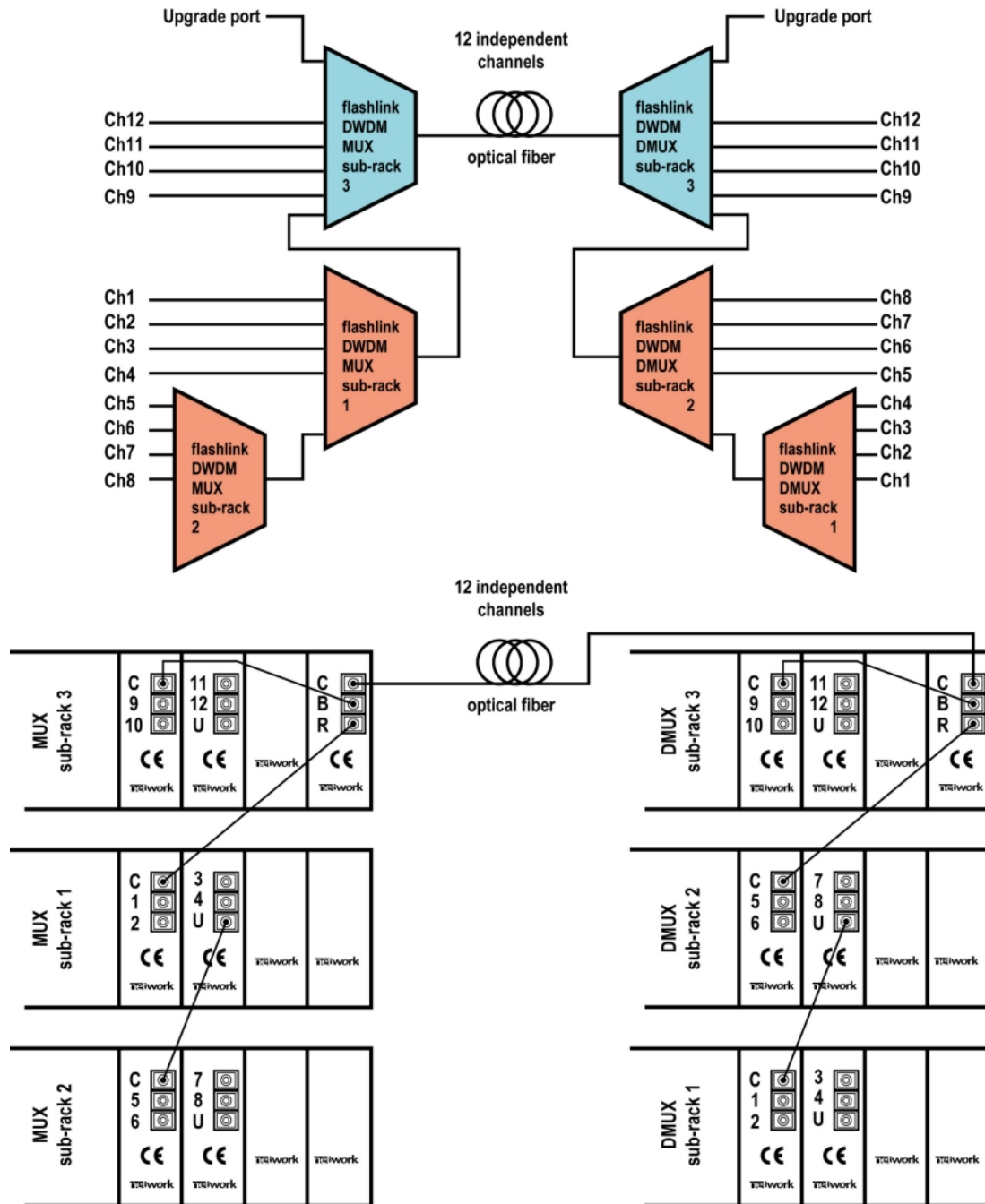


Figure 2.6: 12-channel unidirectional DWDM system, description of system and connections of the sub-racks 1,2 and 3.

In figure 2.7 we see an example of how a bi-directional system can be configured.

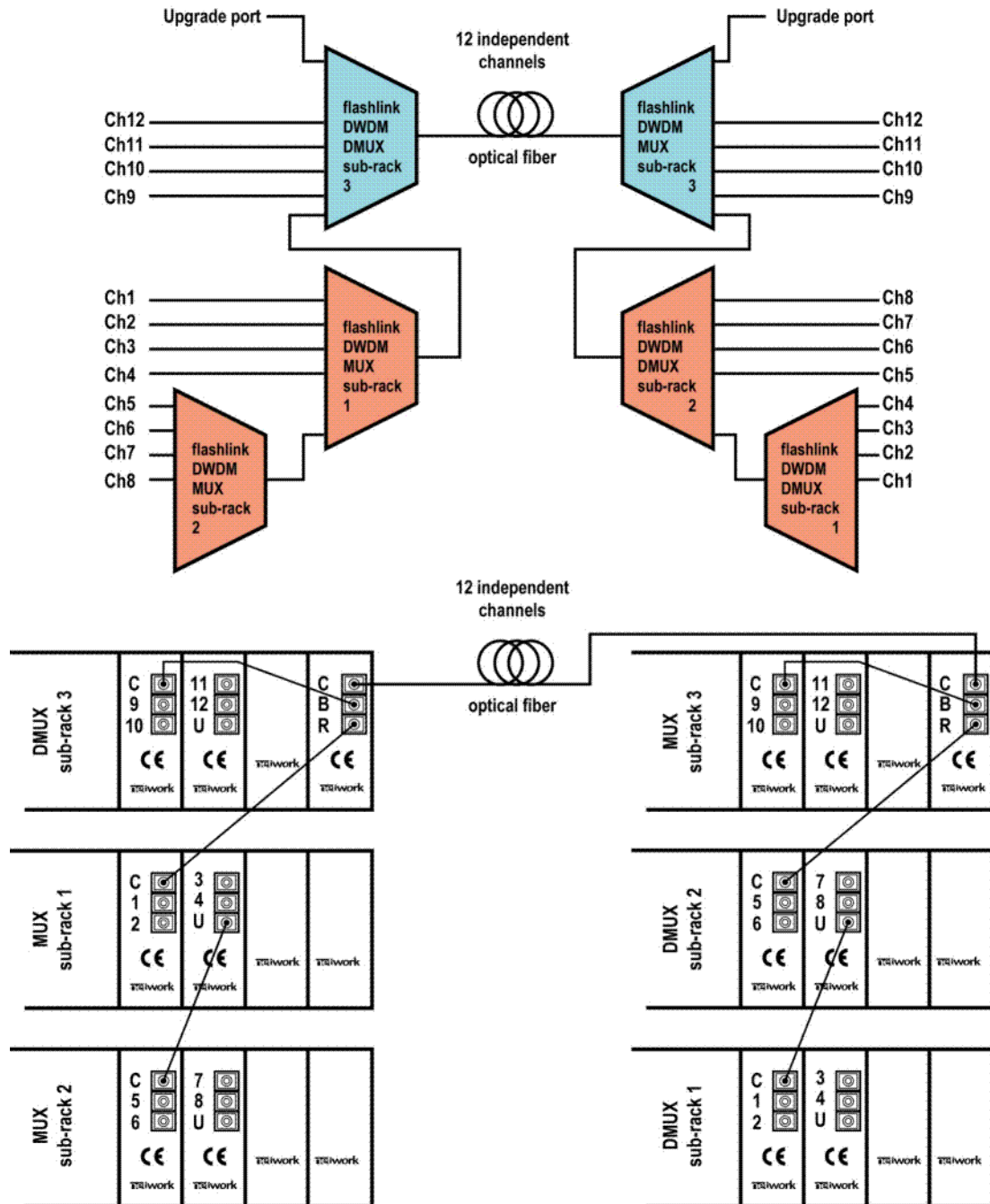


Figure 2.7: 8+4-channel bi-directional DWDM system, description of system and connections of the sub-racks 1,2 and 3. Red wavelengths going from left to right, blue wavelengths going from right to left.

2.4 16-channel systems

Putting 4 sub-rack frames together at each end of the fiber gives a 16-channel DWDM system. Figures 2.8-2.10 show examples of different configurations.

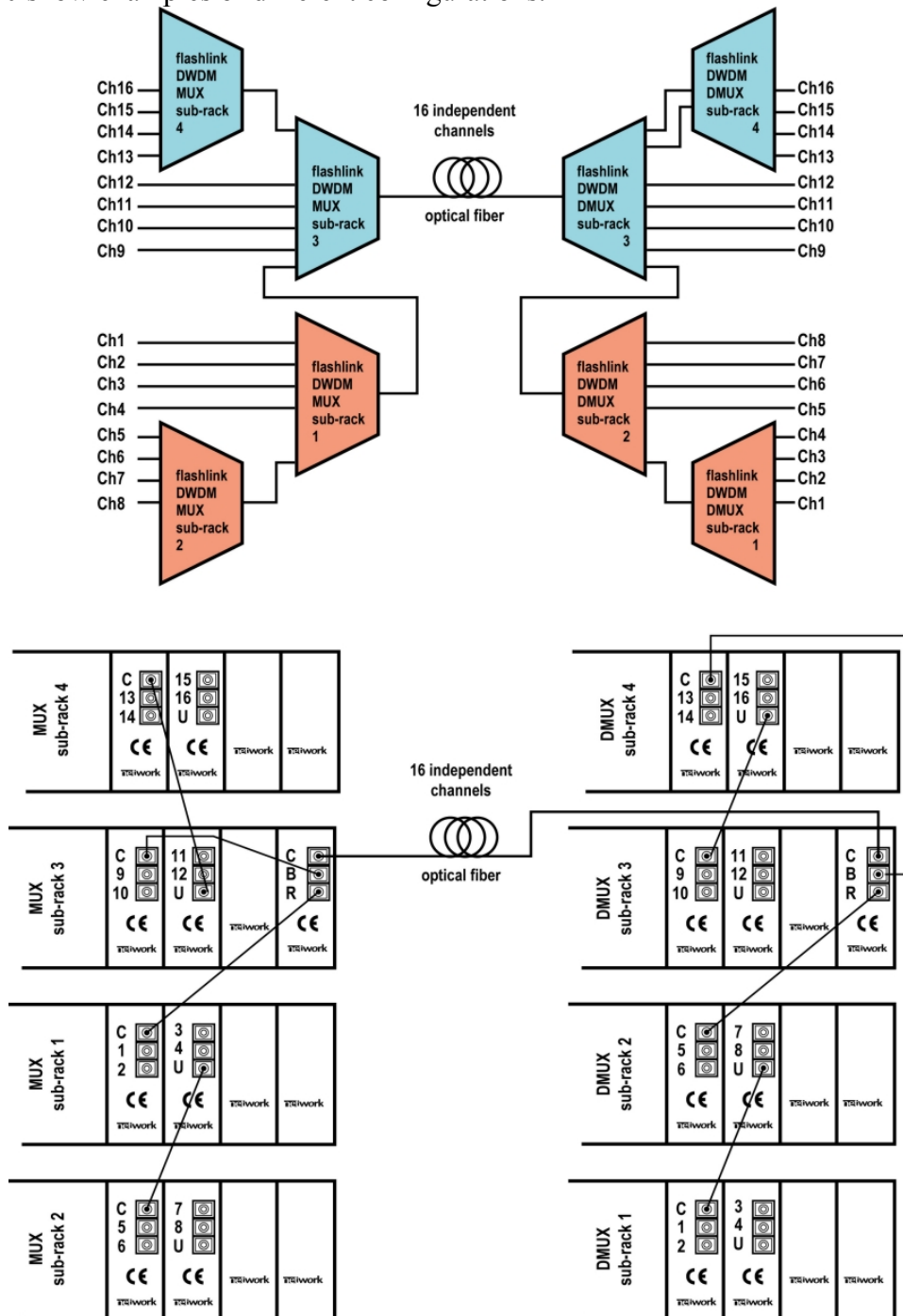


Figure 2.8: 16-channel unidirectional DWDM system, description of system and connections of the sub-racks 1,2,3 and 4.

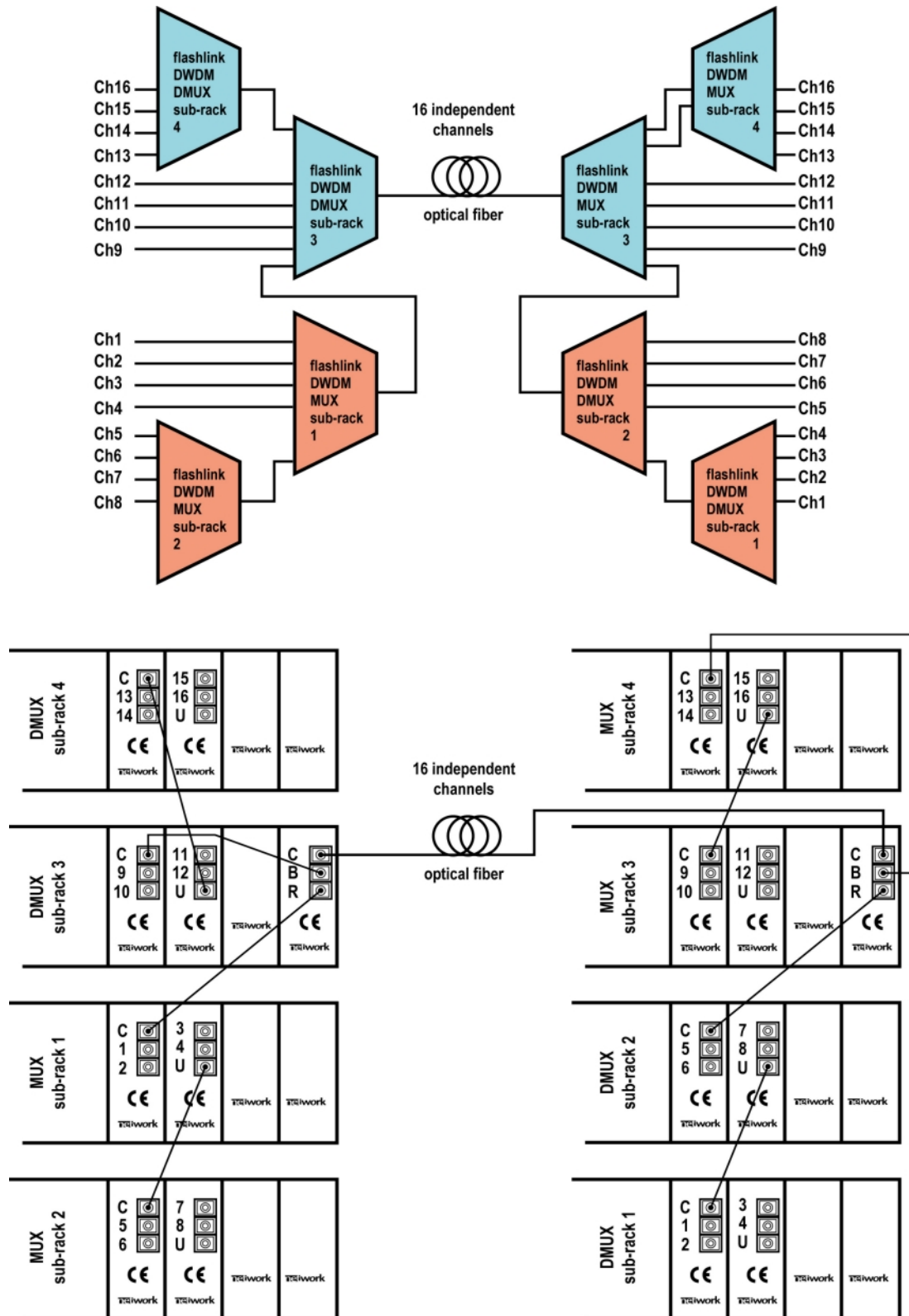


Figure 2.9: 8+8-channel bi-directional DWDM system, description of system and connections of the sub-racks 1,2,3 and 4. Red wavelengths going from left to right, blue wavelengths going from right to left.

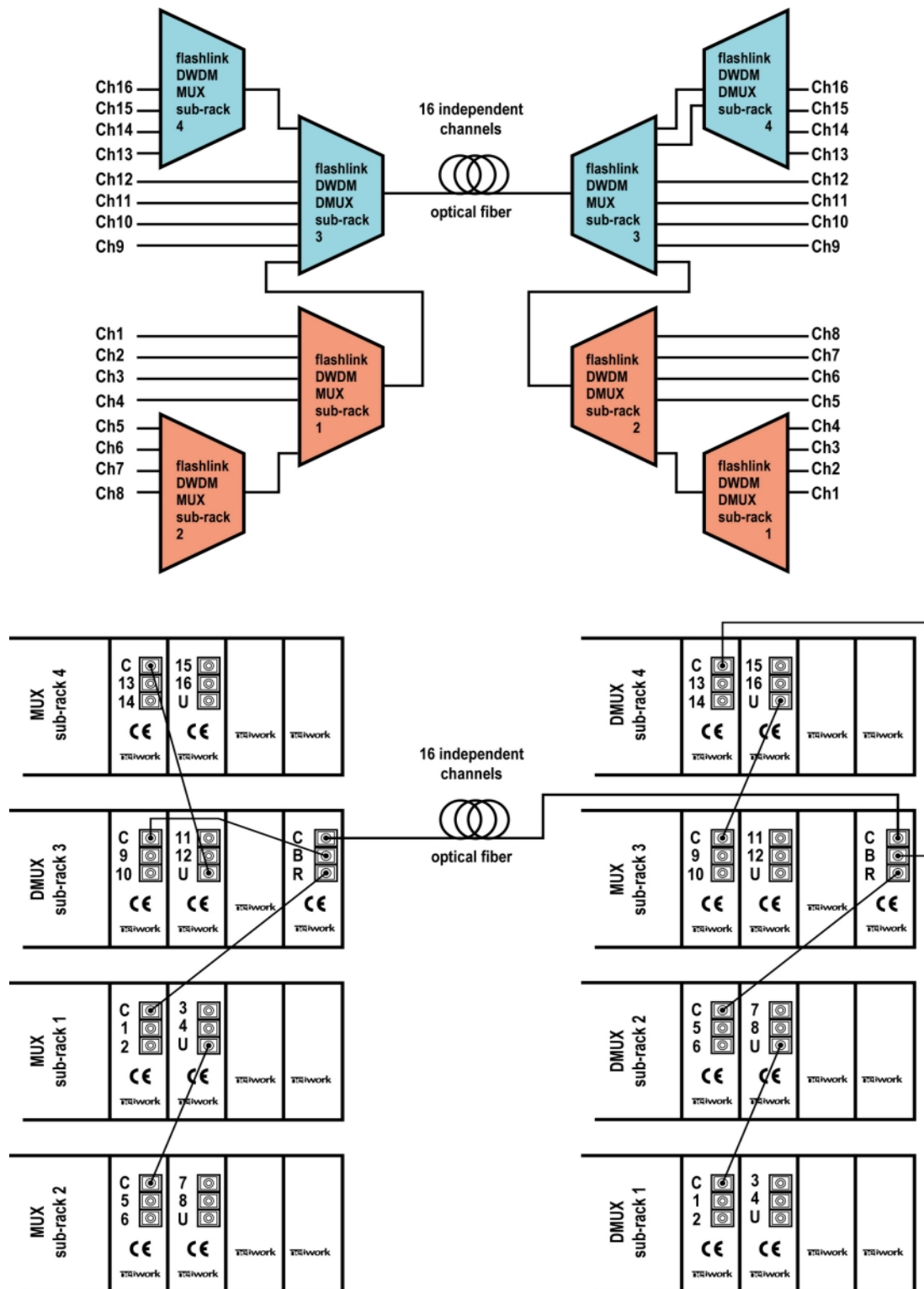


Figure 2.10: 12+4-channel bi-directional DWDM system, description of system and connections of the sub-racks 1,2,3 and 4. 12 channels from left to right, 4 channels from right to left.

2.5 32-channel systems

Figure 2.11 shows the backplane for the flashlink 32-channel DWDM optical filter frame. Each optical port supports a dedicated wavelength that is marked on the sub-rack frame. The connector is an SC/PC connector. Each port should be connected to the corresponding wavelength for each channel card with an optical patch cord. The common port supports all wavelengths in either direction and should therefore be connected to the single fiber between the two locations where the flashlink 32-channel DWDM system is installed. The common port can be fitted with an FC/PC connector on request. The optical filters are sold in pairs using cascaded thin film filters for wavelength selection. This means that the filters are mounted in opposite orders on the two sides. On one side of the optical link the lowest wavelengths has the lowest insertion loss, whereas the lowest wavelength will have the highest insertion loss on the other side. The specification of the 32-channel optical filters can be found in chapter 3.

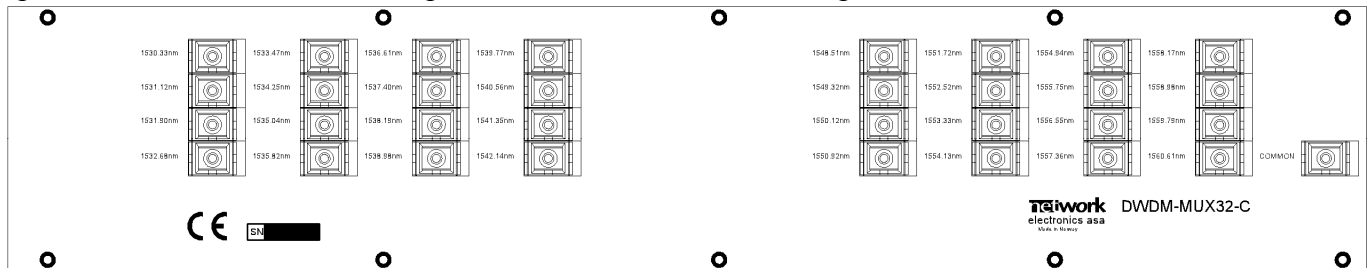


Figure 2.11: The backplane for the 32-channel DWDM system optical filter

2.6 40-channel systems

The configuration of a flashlink 40-channel DWDM-system is the same as for the 32-channel system. Please see section 2.5 for further details. The specification of the 40-channel optical filters can be found in chapter 3.

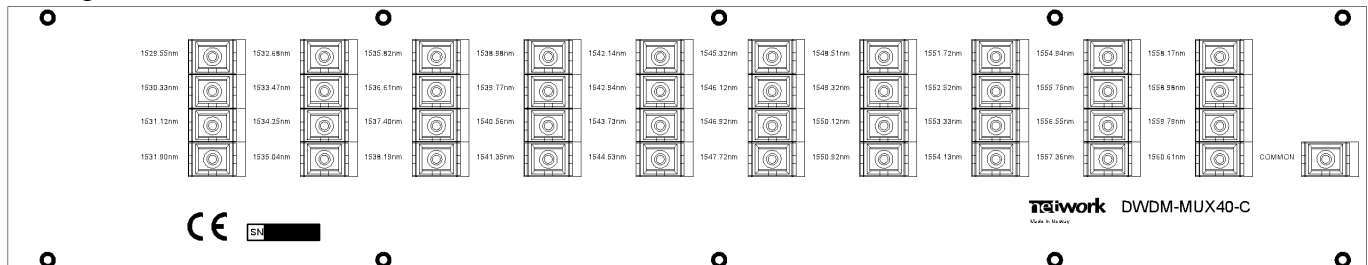


Figure 2.12: The backplane for the 40-channel DWDM system optical filter

3 DWDM system description

The DWDM concept requires defined sub-rack frames (FR-DWDM) with specified MUX-modules and lasers on the transmitter side, and DEMUX-modules and PIN-diodes on the receiver side. Each frame is based on the original flashlink frame, FR-2RU-10-2-F, and contains modules needed for simultaneous transport of 4 format- and protocol-independent signals. FR-DWDM has the same options for power redundancy and system control as the FR-2RU-10-2-F. Note that a point-to-point link always requires the same type of MUX and DEMUX.

The flashlink DWDM-system is available in different versions and configurations. The respective user manuals for the electrical to optical or the optical to electrical interfaces are enclosed with their respective cards. This user manual contains all the optical specifications for the DWDM-system regardless of number of channels.

3.1 Specifications for 16-ch system

AC power:	AC power supply module 100-260 VAC (PWR-AC15/15/5V)
DC power (optional):	DC power supply module 36-72 VDC (PWR-DC15/15/5V)
Redundant power (optional)	
Dimensions:	483 x 88 x 178 mm (19", 2RU)
Card slots	10 (9 reserved)
Power supply slots (reserved)	2
Internal voltages :	+5V, + 15 V, -15 V

Optical Output

Transmission circuit fiber:	Single Mode
Light source:	DFB Laser
Wavelength	Acc. to ITU-T G.692, see separate chapter
Optical power:	0 dBm typ.
Return loss	Better than 30 dB typ.
Maximum reflected power:	4%
Connector	SC/UPC

Optical Input

Data rate optical:	143Mbps – 540Mbps
Sensitivity SDI-OE-L:	better than –30dBm typ.
Maximum input power SDI-OE-L:	-17 dBm
Detector overload threshold:	min. –6dBm, typ. –3dBm
Optical wavelengths:	1200-1600 nm
Transmission Circuit Fiber	Multi Mode 50/125μm, Single Mode compatible
Return loss:	better than 40 dB w/Single Mode fiber (typ.)
Connector	SC/UPC

Insertion loss, all optical filters included

4-channel system	Max. 6dB per mux/demux pair
8-channel system	Max. 8dB per mux/demux pair
12-channel system	Max. 10dB per mux/demux pair incl. R/B split
16-channel system	Max. 10dB per mux/demux pair incl. R/B split

DWDM Dielectric Filter Module

4 Channel Demultiplexer				4 Channel Multiplexer		
Parameter	Min	Max	Units	Min	Max	Units
Insertion loss (any channel) (including 1 connector loss)		3.0	dB		2.5	dB
Channel spacing (ITU Grid compliant)	200		GHz	200		GHz
Crosstalk:						
Adjacent channel		-25	dB		N/A	dB
All other channels		-35	dB		N/A	dB
Return loss		-40	dB		-40	dB
Differential channel loss		1.5	dB		1.5	dB
Tx – Tx directivity		N/A	dB		-55	dB

Notes:

2 devices can be concatenated to give 8-channel capability. (In this case the losses for channels in the second device will incur an additional 2.0dB max. due to transit through first device).

Red/blue split bandpass-filter

Parameter	Min	Max	Units
Blue band λ_1	1528.8	1542.5	nm
Red band λ_2	1547.5	1561.0	nm
Insertion loss of red band (including 1 connector loss)		1.5	dB
Insertion loss of blue band (including 1 connector loss)		1.5	dB
Isolation from red band	10		dB
Isolation from blue band	20		dB
Return loss (all ports)	40		dB
Directivity	60		dB
Polarization sensitivity		0.1	dB

Notes:

This device can combine two 8-channel groups to give 16-channel capability. (In this case the channel loss will increase with 2*1.5dB due to insertion loss of band filter).

Channel overview

The channel wavelengths are specified in a recommendation from the International Telecommunications Union (ITU), called ITU-T G.694.1. The channel spacing in the 16-ch system is 200GHz, whereas the channel spacing within each sub-rack is 400GHz.

Sub-rack 1:

Channel #	ITU-channel	Wavelength
1	Channel 35	1549.32nm
2	Channel 31	1552.52nm
3	Channel 27	1555.75nm
4	Channel 23	1558.98nm

Sub-rack 2:

Channel #	ITU-channel	Wavelength
5	Channel 33	1550.92nm
6	Channel 29	1554.13nm
7	Channel 25	1557.36nm
8	Channel 21	1560.61nm

Sub-rack 3:

Channel #	ITU-channel	Wavelength
9	Channel 59	1530.33nm
10	Channel 55	1533.47nm
11	Channel 51	1536.61nm
12	Channel 47	1539.77nm

Sub-rack 4:

Channel #	ITU-channel	Wavelength
13	Channel 57	1531.90nm
14	Channel 53	1535.04nm
15	Channel 49	1538.19nm
16	Channel 45	1541.35nm

Supported bit rates

Broadcast:

- 143 Mbps Digital NTSC
- 177 Mbps Digital PAL
- 270 Mbps SDI
- 360 Mbps SDI
- 540 Mbps SDI
- 1485 Mbps HD-SDI
- DVB-ASI
- SDTI
- Embedded AES and Data
- SMPTE 310
- M2S (Divicom)

Telecom:

- 140 Mbps E4
- 155 Mbps STM-1 (OC-3c)

Datacom:

- RS-422
- 100 Mbps Fast Ethernet
- 1250 Mbps Gigabit Ethernet

3.2 Optical specifications for 32-channel system

Number of channels	32
Available wavelengths	See section 3.4
Connector	SC/SPC
Insertion loss (per mux/demux pair, including connectors)	9dB max
Insertion loss uniformity	3dB
Channel Spacing	100GHz
Passband	0.2nm min
Adjacent Channel Isolation	25dB min (28dB typ.)
Non-Adjacent Channel Isolation	40dB min
Directivity	45dB min
Thermal Wavelength Stability	1.0 pm/°Cmax
Return loss	40dB min
PDL	0.2dB max (0.1dB typ.)
Operating Temperature	0 – 40 °C
Storage Temperature	-40 – 85 °C
Optical Power	300mW max

3.3 Optical specifications for 40-channel system

Number of channels	40
Available wavelengths	See section 3.4
Connector	SC/SPC
Insertion loss (per mux/demux pair, including connectors)	13.6dB max
Insertion loss uniformity	4dB
Channel Spacing	100GHz
Passband	0.2nm min
Adjacent Channel Isolation	25dB min (28dB typ.)
Non-Adjacent Channel Isolation	40dB min
Directivity	45dB min
Thermal Wavelength Stability	1.0 pm/°Cmax
Return loss	40dB min
PDL	0.2dB max (0.1dB typ.)
Operating Temperature	0 – 40 °C
Storage Temperature	-40 – 85 °C
Optical Power	300mW max

3.4 Wavelength Availability Chart according to ITU-T G.694.1 for 32- and 40-ch systems

ITU Channel No.	Frequency [THz]	Wavelength [nm]	32-ch system	40-ch system	
60	196,00	1529,55		X	Blue wavelengths
59	195,90	1530,33	X	X	
58	195,80	1531,12	X	X	
57	195,70	1531,90	X	X	
56	195,60	1532,68	X	X	
55	195,50	1533,47	X	X	
54	195,40	1534,25	X	X	
53	195,30	1535,04	X	X	
52	195,20	1535,82	X	X	
51	195,10	1536,61	X	X	
50	195,00	1537,40	X	X	
49	194,90	1538,19	X	X	
48	194,80	1538,98	X	X	
47	194,70	1539,77	X	X	
46	194,60	1540,56	X	X	
45	194,50	1541,35	X	X	
44	194,40	1542,14	X	X	Red wavelengths
43	194,30	1542,94		X	
42	194,20	1543,73		X	
41	194,10	1544,53		X	
40	194,00	1545,32		X	
39	193,90	1546,12		X	
38	193,80	1546,92		X	
37	193,70	1547,72		X	
36	193,60	1548,51	X	X	
35	193,50	1549,32	X	X	
34	193,40	1550,12	X	X	
33	193,30	1550,92	X	X	
32	193,20	1551,72	X	X	
31	193,10	1552,52	X	X	
30	193,00	1553,33	X	X	
29	192,90	1554,13	X	X	
28	192,80	1554,94	X	X	
27	192,70	1555,75	X	X	
26	192,60	1556,55	X	X	
25	192,50	1557,36	X	X	
24	192,40	1558,17	X	X	
23	192,30	1558,98	X	X	
22	192,20	1559,79	X	X	
21	192,10	1560,61	X	X	

3.5 Connection drawing

Figure 1 shows the connections of an FR-DWDM sub-rack frame, as seen from the rear. From left to right we see the connector module for the power supply, the connector module for the optional GYDA[®] Rack System Controller, the connector modules for the 4 channels, and the connector modules for the optical filtering of the different channels.

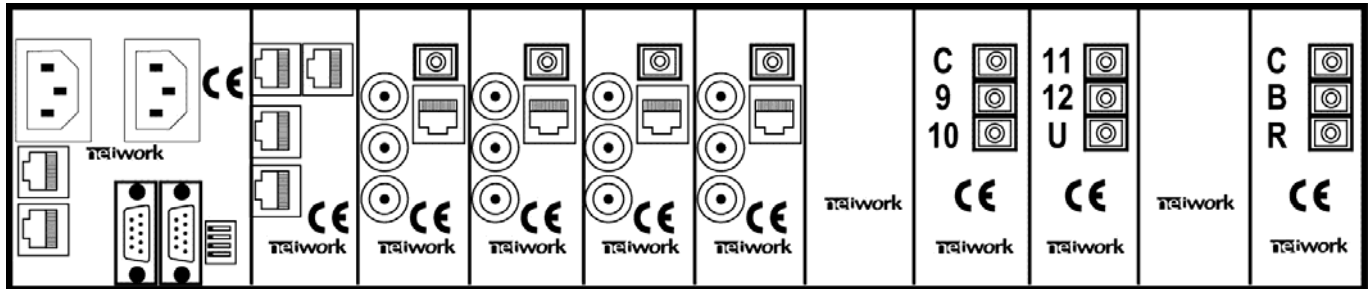


Figure 3.1: Example of fully equipped FR-DWDM with the Gyda[®] Rack System Controller.

3.6 Module card LEDs

The uppermost LED of each module card is a "general status" LED.

Green light means that the card is OK.

Red light means that the card is faulty.

No light means that the power is not switched on.

The meaning of each LED on the module cards is described in their respective user manuals.

Positions 1-5 in the system have only passive modules without LEDs for the 16-ch system.

4 Power connection and RS-422 connection

Figure 4.1 shows the power connections of the sub-rack as well as the RS-422 connections and the DIP-switches for address setting of the sub-rack.

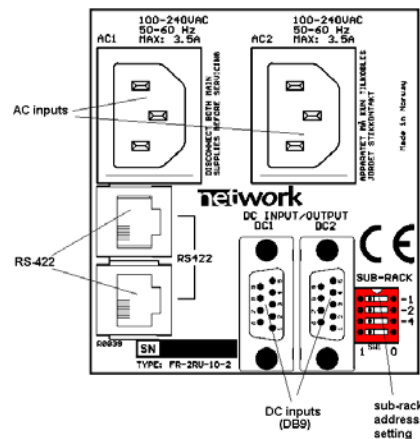


Figure 4.1: Connector module for the power module.

AC: Connect mains to the sub-rack with a mains cord with an IEC 320 connector.

DC: Connect the DB9 male connector from the external DC power supply to the main unit. Tighten the screws to ensure a proper contact. The DC inputs have the same function, the left input (DC1) is for the left power module when seen from the rear and DC2 is for the right power module when seen from the rear.

4.1 Pin-out DB9:

The maximum current drawn from each pin of the DB9 connector is 2,5A.

The power supply is able to deliver an overall maximum current of 5,5A at 5V and 1A at 15V.

The pin-out is the same for both DC1 and DC2.

Pin 1	GND for DC	
Pin 2	+5V	Output
Pin 3	Relay	Open in normal state
Pin 4	+15V	Output
Pin 5	positive part of 48V DC supply	Input
Pin 6	Reserved	
Pin 7	Relay	Open in normal state
Pin 8	-15V	Output
Pin 9	negative part of 48V DC supply	Input

Pin 1, 2, 3 and 8 are common to both DC1 and DC2. (Physically connected).

When the power supply is in operation, a green LED will light on the front.

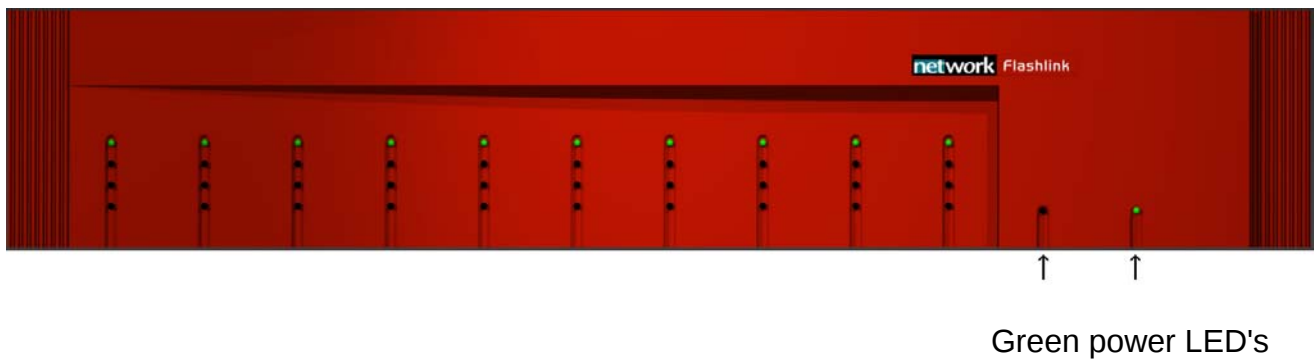


Figure 4.2: The front of the flashlink® frame, showing the power LEDs.

If a redundant power supply solution is used, both power-LED's will show green light.

In the FR-DWDM positions 1-5 contains only optical components with no electrical connections, hence there are no status-LED's in the first five card positions.

4.2. RS-422 connection

At the rear end of the sub-rack is an RS-422 bus. When used in combination with the GYDA®-SC-M Rack System Controller, up to 8 sub-racks can be controlled and monitored. In a DWDM system, one GYDA®-SC-M Rack System Controller will be sufficient on each end of the fiber. Allowing for a 16-channel system to be controlled, with the possibility to control another 16-channel system located at the same place. On the rear end of the sub-rack are DIP-switches where each sub-rack can be assigned its own address (see figure 4.1). The RS-422 interfaces are also shown in figure 4.1.

4.3 Pin-out RS-422

Pin 1	Rx A(+)
Pin 2	Rx B(-)
Pin 3	Tx A(+)
Pin 4	Reserved
Pin 5	Reserved
Pin 6	Tx B(-)
Pin 7	nc
Pin 8	nc

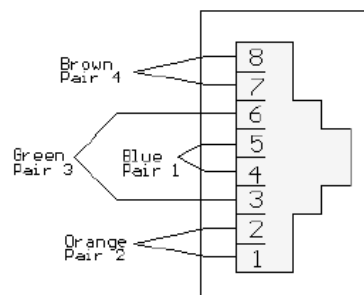


Fig. 4.3 RS-422 inlet

4.4 RS-422 protocol

Hardware interface

The hardware interface is basically RS-422. A serial communication standard much like RS-232 but with balanced lines. You can buy a simple RS-232 to RS-422 converter if you want to use a standard RS-232 port (e.g. a PC COM port).

The receive and transmit lines can be connected to make a true RS-485 bus, but this requires special care from the PC side, since you have to control the bus direction (e.g. using a dedicated RS-485 board with RS-485 drivers). We recommend using RS-422 for control. Data rate: 115200 bps, 8 bits, with one stop bit and no parity. All data is 8 bit ASCII (ISO8859-1 encoding), but currently any ASCII encoding will do). The protocol can be found on our web site <http://www.network-electronics.com/>

Addressing

Each card has a unique identifier called card position, which is assigned (through hardware pinning) automatically when a card is inserted into a sub-rack. The card positions are numbered from 1 to 10 from a user point of view. From a protocol (or software) point of view, the cards are addressed 0-9, but the user should always see positions 1-10 in menus, etc. Each sub-rack (if you use more than one) should have a unique sub-rack id, numbered 0-7 (user and protocol/software wise), more on this in section 4.6.

4.5 Connecting several sub-racks together

There are two versions of the GYDA[®]-SC Rack System Controller.

GYDA[®]-SC-S for control of a single rack

GYDA[®]-SC-M for control of multiple racks

This section only applies to systems including a GYDA[®]-SC-M Rack System Controller.

Several sub-racks can be connected to each other through the RS-422 ports on the rear.

One GYDA[®]-SC-M controller can control maximum 8 sub-racks.

You start with the sub-rack containing the GYDA[®]-SC-M Rack System Controller, and use 1 RS-422 port to loop through to the next.

The last sub-rack connected must be terminated with 110Ω in order to ensure proper operation. The other port of the rack containing the GYDA[®]-SC Rack System Controller must be left open, and cannot be connected to other sub-racks.

Figure 4.4 shows an example of how to connect 8 sub-racks together as seen from the rear end.

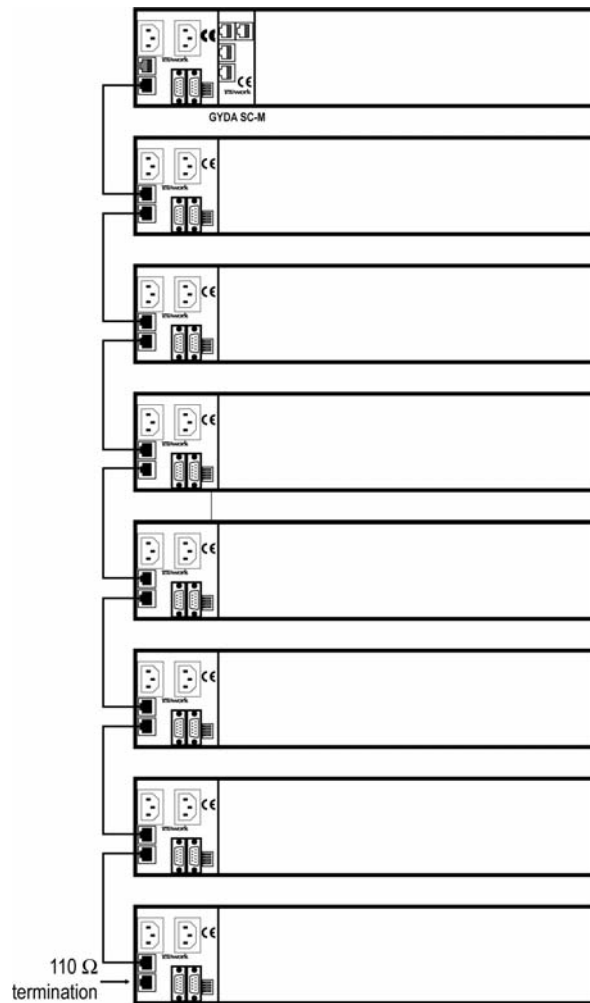


Figure 4.4: Control of 8 sub-racks with GYDA[®]-SC-M.

4.6 Address setting on each sub-rack

Each sub-rack can be assigned an address through the DIP-switches on the rear. Maximum 8 sub-rack addresses are available.

This address setting only applies when the sub-rack is used in combination with a GYDA[®]-SC-M Rack System Controller.

If you have more than 8 sub-racks together, you need several GYDA[®]-SC-M Rack System Controller cards.

!! In order to ensure proper operation of the system, it is important that no sub-racks controlled by the same GYDA[®]-SC-M Rack System Controller card have the same address set. Reset the sub-rack after reconfiguring the sub-rack system. The last sub-rack frame must be terminated with a 110Ω resistor.

The setting of the address of a sub-rack is as follows:

Address:

0 means switch to the right

1 means switch to the left

Address	4	2	1
0	0	0	0
1	0	0	1
2	0	1	0
3	0	1	1
4	1	0	0
5	1	0	1
6	1	1	0
7	1	1	1

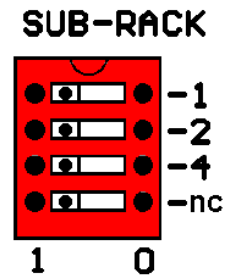


Fig. 4.5 DIP-switch

The GYDA-SC Rack System Controller automatically detects the position of the cards within each sub-rack.

More detailed information on the RS-422 configuration can be found in a separate document and at our web site: <http://www.network-electronics.com/>

5 Module card mounting

In order to replace modules within a sub-rack, the front panel must be removed. Each module has a corresponding connector module at the rear.

!! Be careful when swapping module cards. If a receiver card is removed from the sub-rack, an invisible laser beam may be emitted inside the sub-rack from the laser at the other end. The laser beam might be harmful to your eyes.

5.1 Removing the front panel

Detach the front panel by putting your fingers on the right hand side of the front panel and pull gently, as shown in the figures below. Then pull the front panel slightly to the right before removing it.

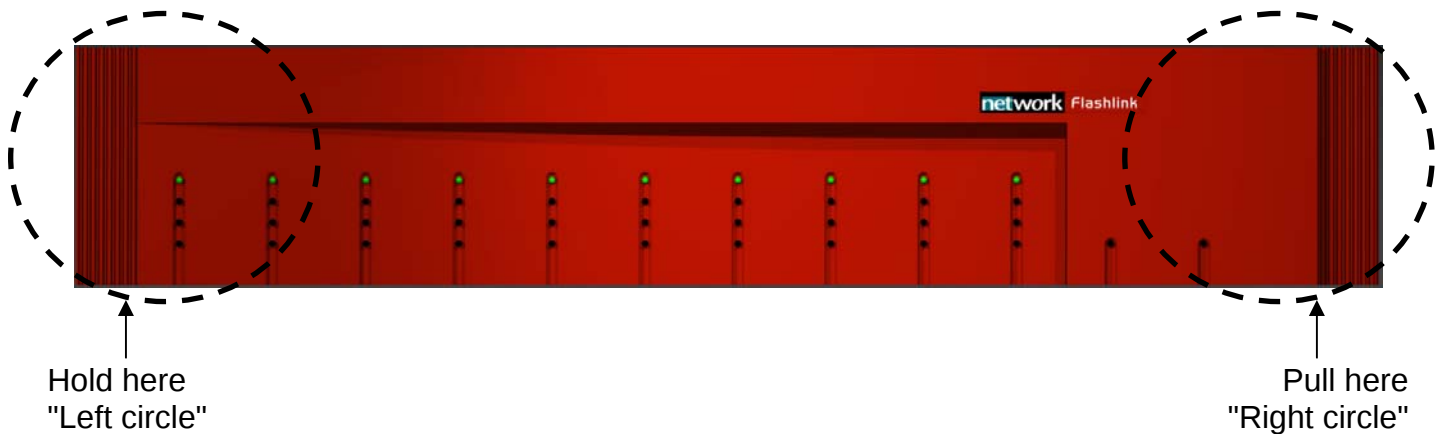


Figure 5.1: Removing the front panel

A more detailed description of how the front panel is detached is given in figure 5.2.

Step 1 looks at the details in the "right circle" seen from the right hand side, whereas the next two steps (step 2 and step 3) give the details of the "left circle" as seen from the top.

DETACHING THE FRONT PANEL

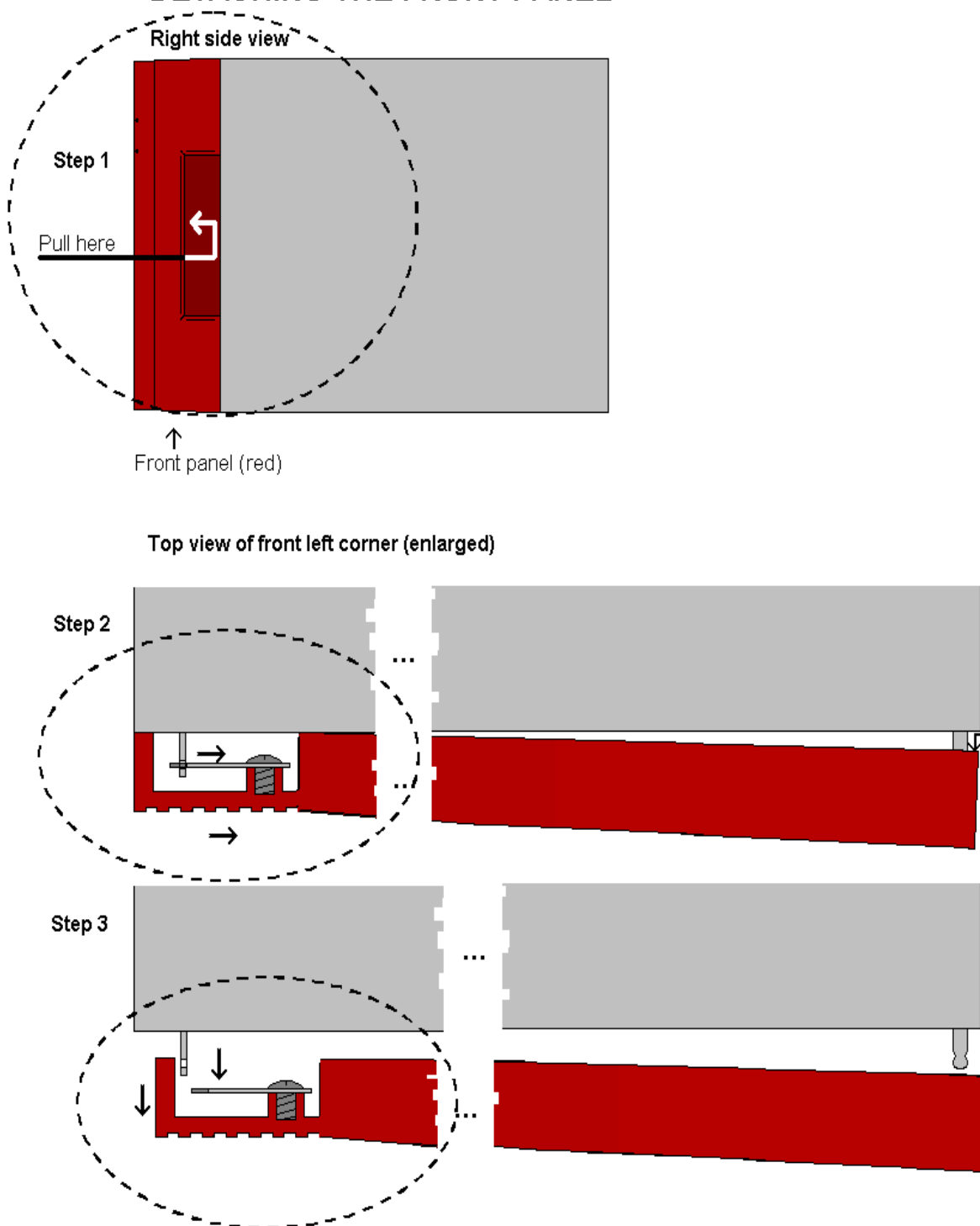


Figure 5.2: Removing the front panel (continued)

5.2 Card insertion

After the front panel is removed, full access to the card modules inside the sub-rack is given. Switch off the power with the power switch on the power-supply modules. The green light on the power module is now switched off. If the power supply is redundant, make sure that both power supplies are off.

The sub-racks are equipped with plastic guide rails to align the module cards into their respective positions 6 to 10. Just before the cards are inserted one should remove the plastic cap from the fiber ferrule as shown in figure 5.3. Do not touch the ferrule tip with your fingers.

Remove plastic cap before inserting module cards

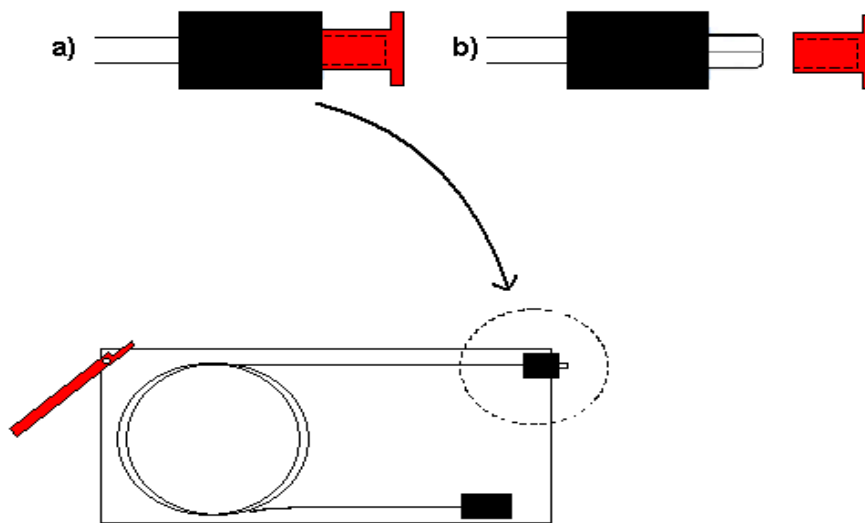


Figure 5.3: Removal of plastic cap (colour most often red or black)

SUB-RACK SEEN FROM THE FRONT WITH THE FRONT PANEL REMOVED

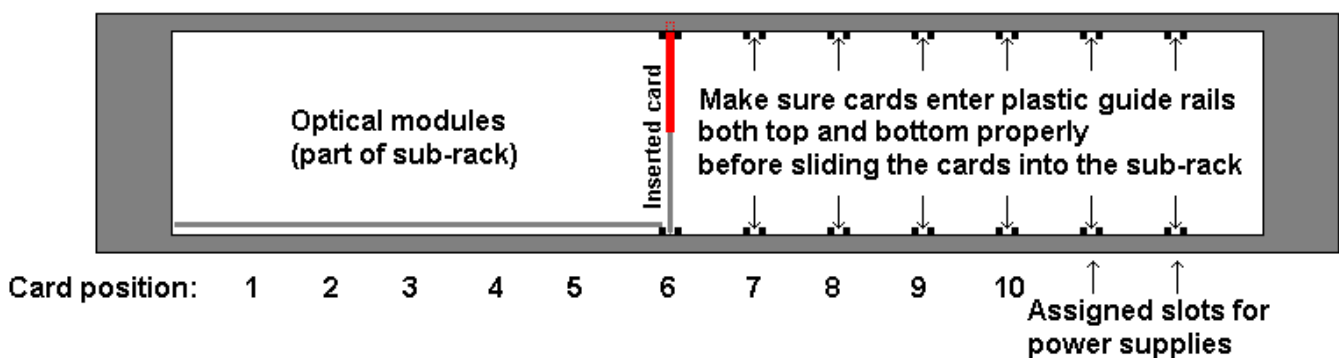


Figure 5.4: Overview of card positions inside an FR-DWDM sub-rack

!! Be careful when inserting the card into the sub-rack. The ferrule of the fiber may be damaged if it touches the sub-rack walls. Do not touch the ferrule tip with your fingers.

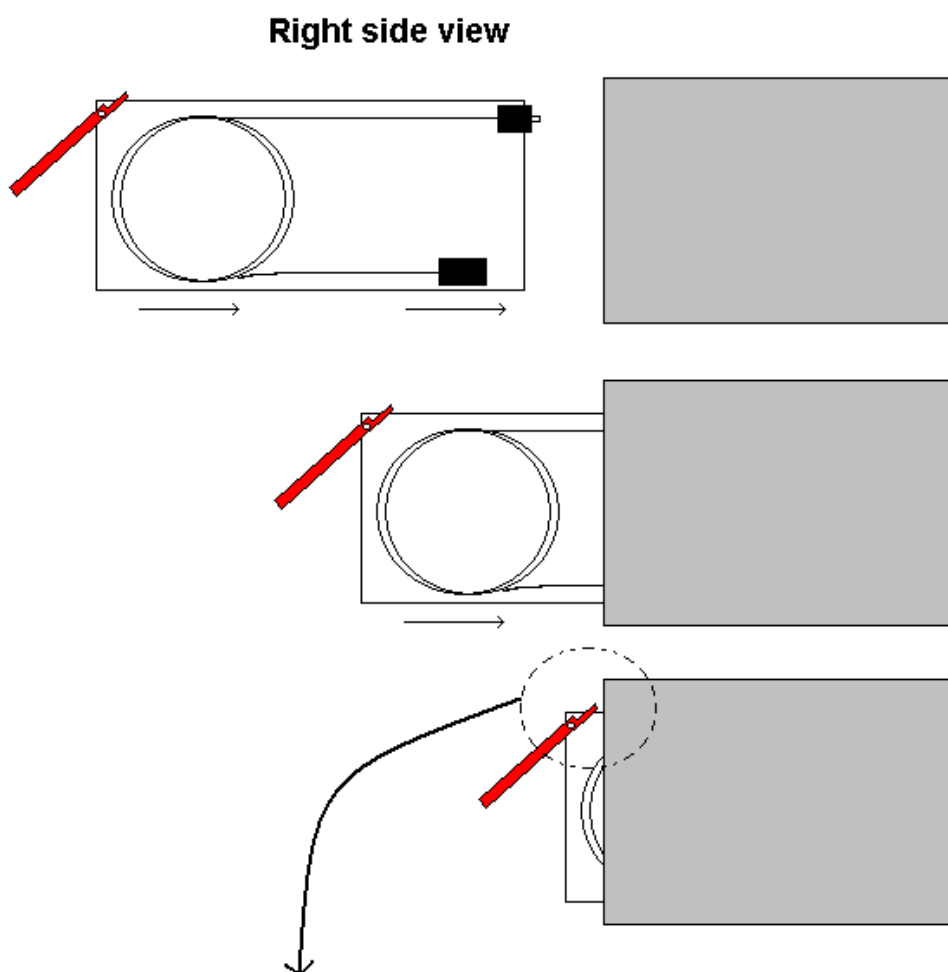


Figure 5.5: Inserting module cards

Slide the card into the plastic guide rails inside the sub-rack until the red handle is close to the sub-rack front. A detailed description of the last part of the insertion process is shown in figure 5.6.

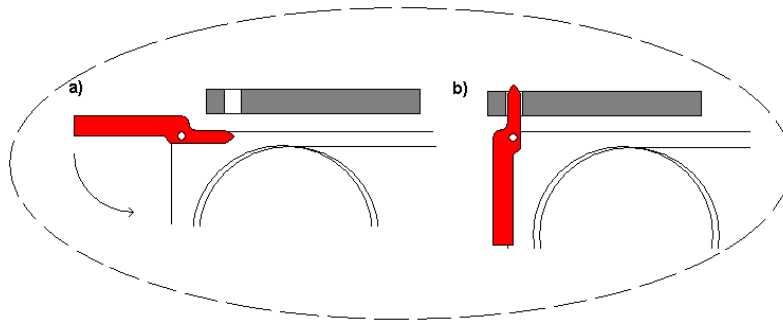


Figure 5.6: Inserting module cards (continued)

On the top of the rack is a hole above each module slot. When the tip of the handle is just below this hole, start bending the handle downwards as in figure 5.6 a). The tip of the handle enters the hole and the card is locked and proper contact ensured when the handle is in upright position (figure 5.6 b)).

5.3 Card removal

To remove a module card from the sub-rack frame, release the card by pulling the red handle until it is in horizontal position see figure 5.7 a). Then pull the card out of the sub-rack with the red handle (figure 5.7 b). After removing a card, it is important that the protective cap is put back on the ferrule tip (figure 5.7 c) and d).

!! When removing a receiver card from the sub-rack, the laser beam may be present inside the sub-rack (transmitted through the fiber). To avoid damaging your eyes, never look directly into the sub-rack unless you are 100 % sure that no laser beam is present inside the sub-rack.

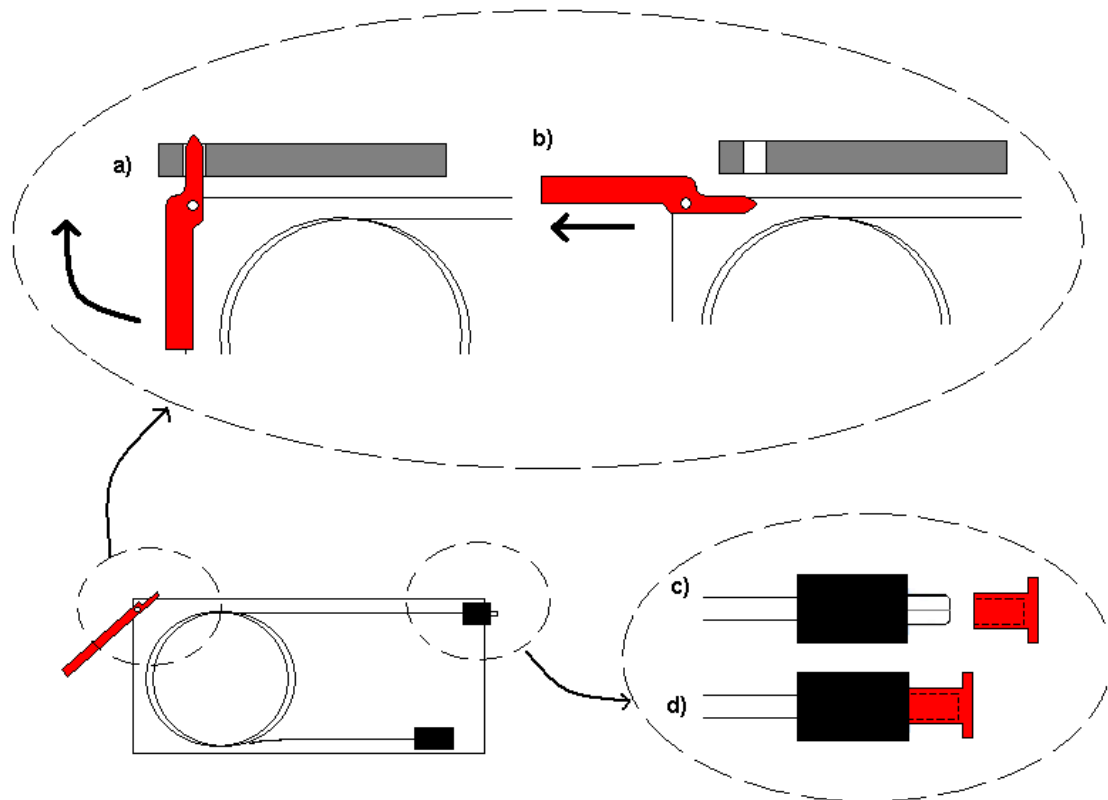


Figure 5.7: Removal of module card.

5.4 Attaching the front panel

To attach the front panel, we reverse the process described in section 5.1. Start by switching on the power supplies.

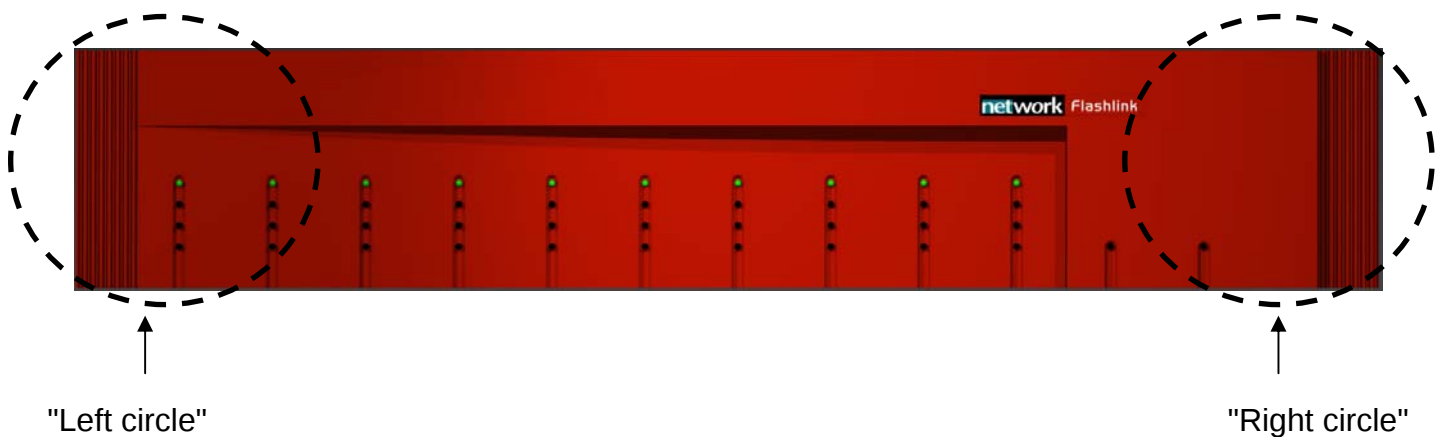


Figure 5.8: Attaching the front panel

We start in the "left circle" and slide the front into the slot as described in figure 5.9.

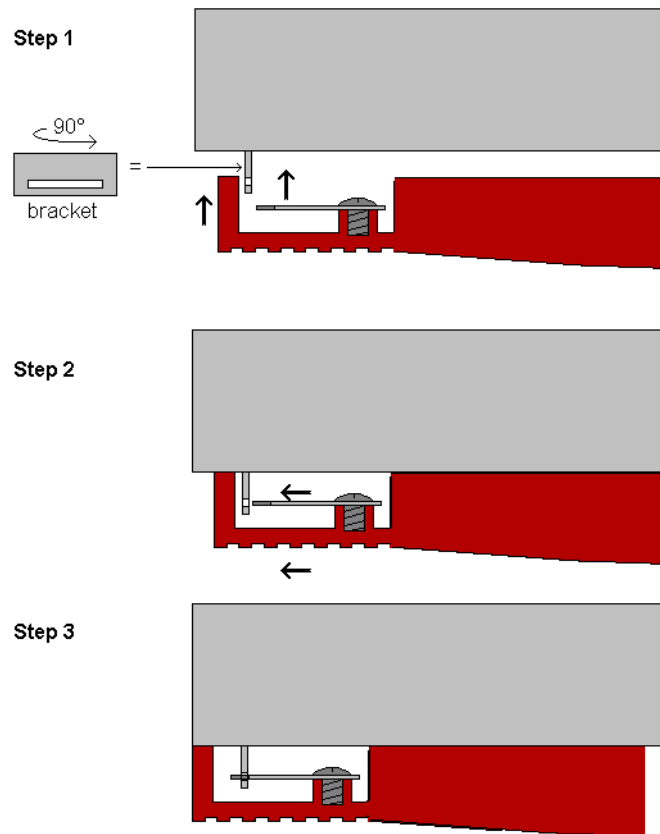


Figure 5.9: Attaching the front panel (Top view of front left corner).

After the front is attached to the left part of the sub-rack we attach in to the right part as shown in figure 5.10.

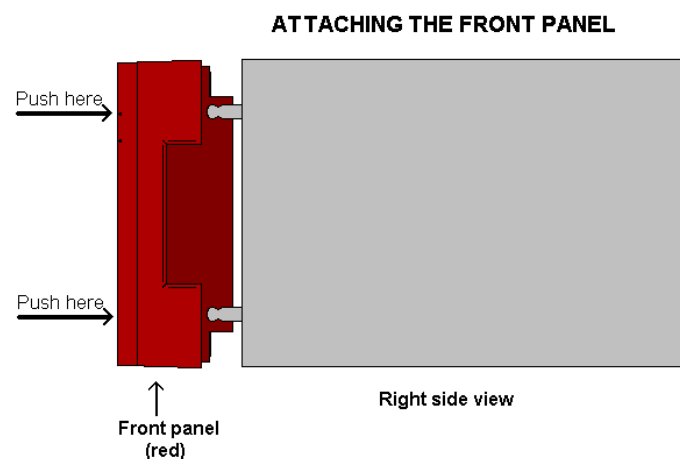


Figure 5.10: Attaching the front panel (continued)

A click sounds, and the front is attached.

6 Fiber optics

The FR-DWDM houses fiberoptic equipment.

Even though a fiberoptic cable can look almost the same as an electrical wire, special care must be taken. Inside the cable is a fiber made of glass. Glass has very different physical properties than the copper used in electrical wires.

6.1 Handling of optical fibers

In practical terms this means that these precautions must be taken:

- Do not bend the fiber too much
- Do not put anything on top of the optical fiber.
- Keep the connectors clean from dust

If a fiber is bent too much, parts of the transmitted light is lost.

We can compare light transmission through an optical fiber with driving a car at maximum speed. We want the road to be as straight as possible. The probability that your car is still on the road at the other end of the turn decreases with increasing curvature of the turn. Although there is a major difference: The transmitted light is gradually lost when the curvature increases, while your car is either on the road or not.

Therefore all the datasheets of optical fibers have a point called "minimum bend radius" or something similar. This means that any bending of the fiber corresponding to a bend radius less than the given value, will make the light leak out of the fiber.

A typical value is 20 mm to 40 mm (Bellcore standard) for single mode fibers.

You should also avoid putting any heavy items on top of the optical fibers, because this will change the optical properties of the fiber, and contribute to errors in the transmitted signal.

Unless the fiber is damaged, it will regain its optical properties after a bend is straightened out or the items are removed / the squeeze is released.

6.2 Fiber optic Connector

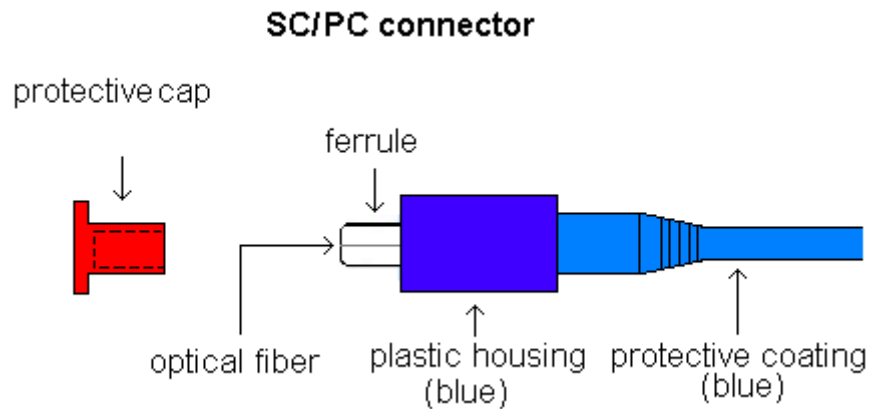


Figure 6.1: The different parts of an SC/PC Connector. Protective cap and coating may have different colour.

The flashlink product range utilises ultra polished SC/PC connectors (SC/UPC). These connectors have a return loss of better than 40 dB typ.

As compared to an electrical connection between two points, an optical connection is much more dependent on clean connectors. A dirty connector can add up to 10 dB of attenuation to your link. Either you have light entering the receiver or you have not. If there is no light at the receiver, then no signal will be detected. So the difference between an errorless connection over fiber, and no connection at all can be a dirty connector. See figs. 6.2 and 6.3.

Therefore: Clean connectors are of crucial importance.

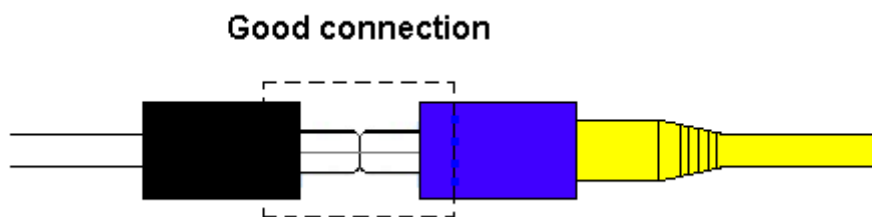


Figure 6.2: Good connector connection

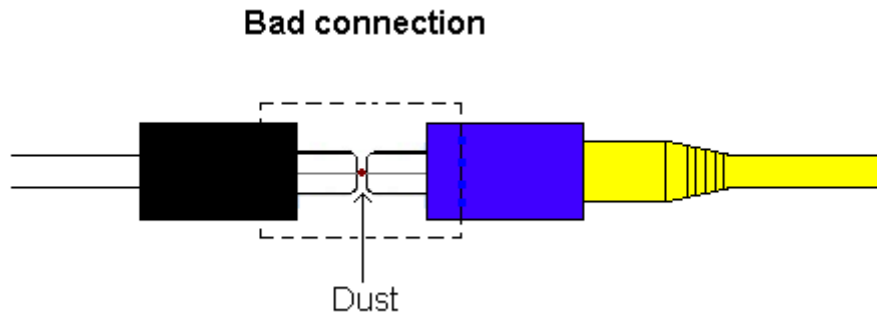


Figure 6.3: Bad connector connection

This also implies that people working with patching of fiber connectors must be aware of this.

An optical fiber is made of glass and must be treated as such, not as an electrical wire. Compare it to the lens of a camera. You don't want fingerprints on the lens, but since the lens area is large compared to the cross-sectional area of a single mode fiber some light will pass the lens. The photo will be exposed but with degraded quality. A single mode optical fiber with a cross-sectional area of circa 1/10 000 000 000 square meter is far more dust-sensitive. To protect the connectors from dust, one shall always put on the plastic cap (red or other colour) which is on the connector end at delivery (or enclosed in a plastic bag) whenever a fiber end is disconnected.

If there is a chance that the fiber connector is dirty, one should clean the connector before putting it close to a clean fiber ferrule. If a clean connector is pressed against a dirty connector, both connectors will become dirty resulting in degradation of signal quality. Or even worse, you may damage the surface of the connector(s).

Using a special cleaning-tape suitable for this purpose does the cleaning. You may also use a soft tissue and iso-propyl alcohol, or dry and oil-free pressurised air.

To blow on the tip of the ferrule will not be sufficient.

More information on fiber optics can be found on our web site:

<http://www.network-electronics.com/>

6.3. DWDM background

DWDM is a multiplexing technique to increase the bandwidth on a single mode optical fiber, enabling simultaneous transport of several different signals on one fiber. The all-optical multiplexing technique is format as well as protocol independent, enabling transport of different signal formats on different wavelengths at the same time.

The forerunner of DWDM, Wavelength Division Multiplexing (WDM) enabled transmission of two signals, one in the second optical window around 1310nm and the other in the third optical window around 1550nm. (The first optical window around 850nm is used for very short-range multi mode fiber links). The principle of WDM is shown in figure 6.4 a). Two channels are transmitted in the same fiber, one in each optical window, hence doubling the capacity of the optical fiber. A DWDM solution can reach longer distances than a WDM solution, because the attenuation in optical fibers is higher in the

second window than in the third window. DWDM utilises only the third window with lower attenuation, and is therefore capable of reaching longer distances than standard WDM.

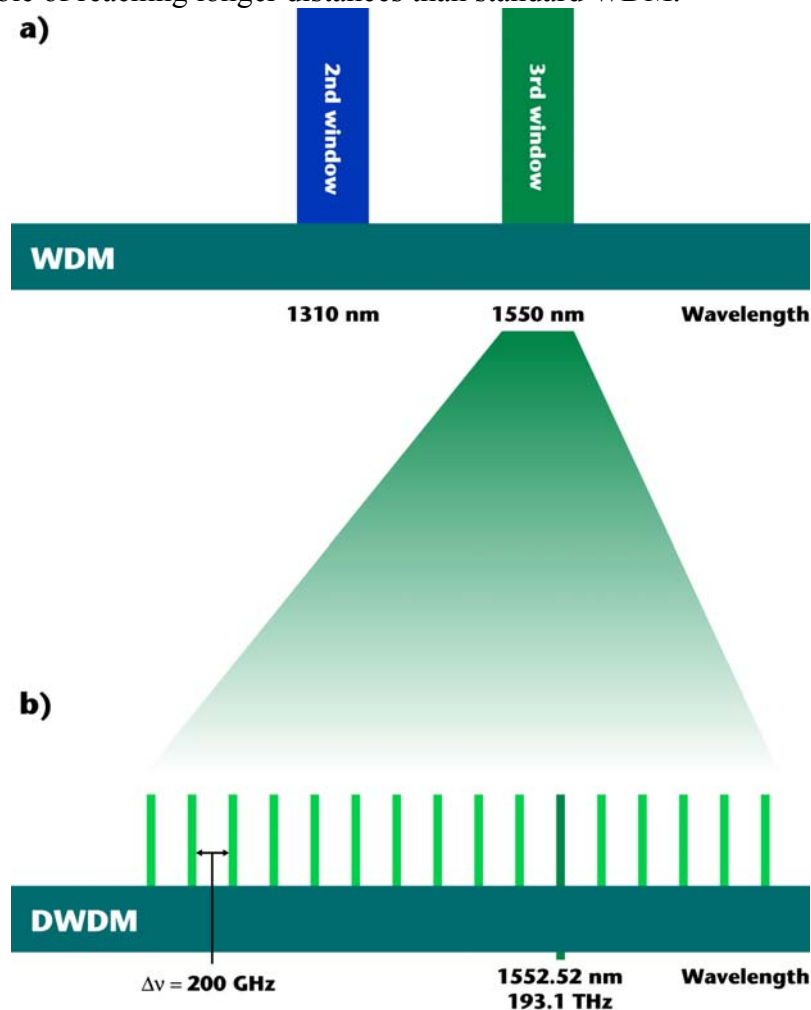


Figure 6.4: Wavelength-band utilisation in a) WDM systems and b) DWDM systems.

From figure 6.4 b) we see that the capacity of the fiber is multiplied 16-fold by utilising the principle of DWDM, where many closely spaced channels within the third window are transmitted simultaneously through one single mode fiber. A channel spacing of 100GHz allows for 40-fold multiplication of the fiber capacity.

The centre-wavelength of each channel is exactly specified by the International Telecommunication Union (ITU), in the recommendation ITU-T G.692. The reference frequency is 193.1 THz, corresponding to a wavelength of 1552.52nm. All the allowed DWDM channels are related to this frequency through the relation

$193.1 \text{ THz} \pm n \cdot 50 \text{ GHz}$, where n is an integer. The flashlink[®] system uses $n=4$ or $n=2$ giving a channel spacing $\Delta\nu$ of respectively 200 GHz or 100GHz.

The reason for using frequency as reference instead of wavelength is the physical nature of light. The frequency is not dependent on the transmission medium properties, as is the case for the wavelength.

DWDM systems demand much better laser wavelength accuracy and filtering characteristics than WDM systems. A typical specification of centre-wavelength of standard non-DWDM lasers is $1550 \pm 20 \text{ nm}$. Compare this to the channel spacing in a 40-channel DWDM system of approximately 0.8 nm, and the conclusion is that non-DWDM lasers cannot be used for DWDM applications. In DWDM systems a narrow spectrum and excellent wavelength stability is of crucial importance, because only a small drift in centre-wavelength of one of the DWDM lasers may distort the signal of the adjacent channel. The allowed wavelength drift of the laser is specified in ITU-T G.692. Larger wavelength drift of a DWDM laser and error-free transmission of multiple SDI signals over single mode optical fiber will never occur at the same time.

To overcome this possible cause of error, the stabilisation circuitry of the DWDM lasers as well as the PCB-layout and the optical filters must be designed properly. This is the only way to ensure that the signal wavelengths of the different channels will not interfere due to changes in the ambient temperature.

The flashlink[®] DWDM system is delivered with frames in pairs. A transmitter frame and a corresponding receiver frame.

6.4 Transmission budget

A transmission budget is an important part of planning an optical link.

An optical link is the place where the signals are transmitted as light through optical fiber and optical components.

The total transmission budget is the difference between the laser output power and the receiver sensitivity.

Example: A 0dBm laser and a -30dBm receiver gives a transmission budget of 30 dB.

Which means that the signal can be attenuated by 30 dB between the laser and the receiver while still being recoverable.

Patch panels, splices, optical filters and other optical components will add attenuation to the optical link. An estimate of the attenuation in the optical filters in the flashlink[®] DWDM-system is found in chapter 1.

It is not recommended to use the entire available budget, one should have 3 dB margin to compensate for future degradation of the optical link.

6.5 flashlink® 16-channel 200GHz DWDM Wavelength Availability acc. to ITU-T G.694.1

ITU Channel No.	Frequency [THz]	Wavelength [nm]	flashlink® sub-rack position		
60	196,00	1529,55			Blue wavelengths
59	195,90	1530,33	SR-3		
58	195,80	1531,12			
57	195,70	1531,90		SR-4	
56	195,60	1532,68			
55	195,50	1533,47	SR-3		
54	195,40	1534,25			
53	195,30	1535,04		SR-4	
52	195,20	1535,82			
51	195,10	1536,61	SR-3		
50	195,00	1537,40			
49	194,90	1538,19		SR-4	
48	194,80	1538,98			
47	194,70	1539,77	SR-3		
46	194,60	1540,56			
45	194,50	1541,35		SR-4	
44	194,40	1542,14			Red wavelengths
43	194,30	1542,94			
42	194,20	1543,73			
41	194,10	1544,53			
40	194,00	1545,32			
39	193,90	1546,12			
38	193,80	1546,92			
37	193,70	1547,72			
36	193,60	1548,51			
35	193,50	1549,32	SR-1		
34	193,40	1550,12			
33	193,30	1550,92		SR-2	
32	193,20	1551,72			
31	193,10	1552,52	SR-1		
30	193,00	1553,33			
29	192,90	1554,13		SR-2	
28	192,80	1554,94			
27	192,70	1555,75	SR-1		
26	192,60	1556,55			
25	192,50	1557,36		SR-2	
24	192,40	1558,17			
23	192,30	1558,98	SR-1		
22	192,20	1559,79			
21	192,10	1560,61		SR-2	
20	192,00	1561,41			

7 3R regeneration

7.1 Introduction

The 3R-regeneration product is a flashlink 2RU frame with both an optical demultiplexer and a multiplexer, fitted with one to four of either MR-TR or SDI-TR cards, or a mixture of the two. 3R functionality means, Re-amplification, Re-clocking and Re-shaping, one R for each of the processes, giving a complete restoration of the optical signals.

A block diagram of the function is shown in figure 7.1:

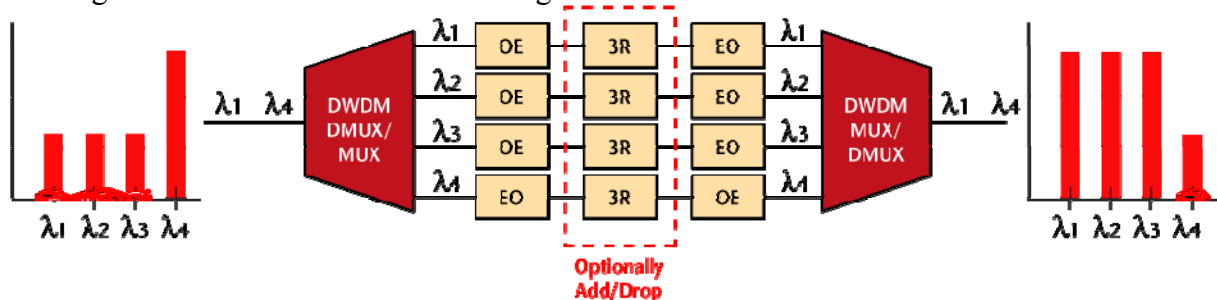


Figure 7.1: A schematic overview of 3R-regeneration. In this case, three DWDM wavelengths travel from left to right, and one from right to left.

The first step is optical demultiplexing.

The second step is optical to electrical conversion

The third step is electrical regeneration of the signals

The fourth step is electrical to optical conversion

The fifth step is optical multiplexing

All these operations can be done for four separate DWDM wavelengths within a single flashlink frame, occupying only 2RU of rack space, the 3R product range is well suited for installations where rack space is at a premium. Basically the 3R-regeneration product line is used for long haul DWDM systems where full electrical regeneration of the signals is needed, thereby effectively extending the maximum reach of the system beyond the limits of single hop optical links. The other case is when the wavelength count is low, therefore making the 3R regeneration product a more economically viable solution than the erbium doped fiber amplifier (EDFA).

An EDFA solution needs each direction to be amplified separately, whereas the 3R solution allows for bi-directional traffic on the same fiber. Using the MR-TR cards to execute steps 2 to 4 above, gives a very good flexibility in signal formats. All digital broadcast formats are supported as well as the popular telecom and datacom formats.

The 3R product family consists of the following frames with modules fitted into the frames according to system demands:

Frames:

3R-2RU-DWDM-1	Flashlink 2RU frame DWDM with both Optical Multiplexer and Demultiplexer, for channels 1 to 4 . Incl. single power supply, RS-422 control, prepared for redundant power, optionally DC power, mixed AC - DC operation. See Module Options below
3R-2RU-DWDM-2	Flashlink 2RU frame DWDM with both Optical Multiplexer and Demultiplexer, for channels 5 to 8 . Incl. single power supply, RS-422 control, prepared for redundant power, optionally DC power, mixed AC - DC operation. See Module Options below
3R-2RU-DWDM-3	Flashlink 2RU frame DWDM with both Optical Multiplexer and Demultiplexer, for channels 9 to 12 . Incl. single power supply, RS-422 control, prepared for redundant power, optionally DC power, mixed AC - DC operation. See Module Options below
3R-2RU-DWDM-4	Flashlink 2RU frame DWDM with both Optical Multiplexer and Demultiplexer, for channels 13 to 16 . Incl. single power supply, RS-422 control, prepared for redundant power, optionally DC power, mixed AC - DC operation. See Module Options below

Modules:

SDI-TR-D15xx.xx	Multirate Optical to Optical Transponder. Optical Input 1200nm - 1620nm, -3dBm to -30dBm. Optical Output 15xx.xx nm Single Mode, DWDM DFB Laser, 19.4-540Mbps. Additional Electrical Input and Output. Supports SDI, SDH, Sonet, DVB-ASI, SMPTE-310
MR-TR-D15xx.xx	Multirate Optical to Optical Transponder. Optical Input 1200nm - 1620nm, -3dBm to -25dBm. Optical Output 15xx.xx nm Single Mode, DWDM DFB Laser, 19.4-1485Mbps. Additional Electrical Input and Output. Supports SDI, HD-SDI, SDH, Sonet, Gigabit Ethernet, DVB-ASI, SMPTE-310

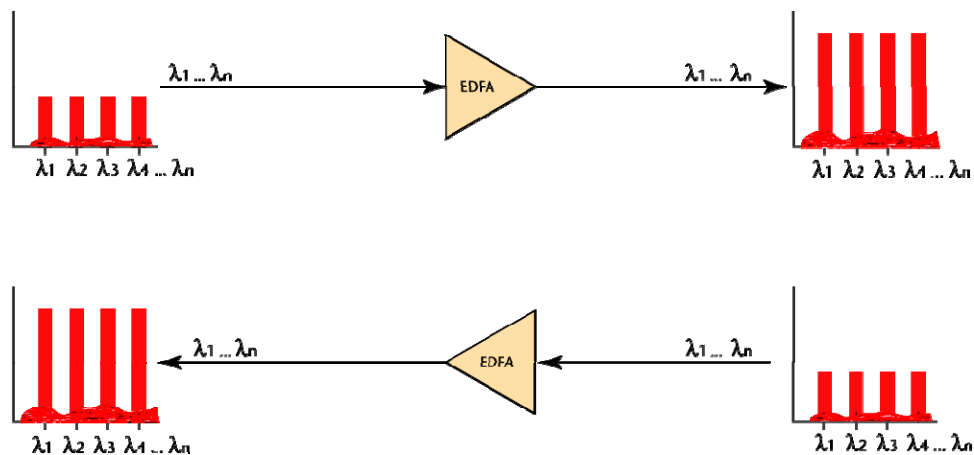


Figure 7.2: An EDFA is used for uni-directional transport of multiple DWDM wavelengths. Bi-directional traffic needs one EDFA per direction.

Product features:

- Regeneration of 4 DWDM wavelengths per 2RU rack space
- DWDM wavelengths are ITU-T G.694.1 wavelength compliant
- Broadcast, data and telecom applications
- Wavelength transponding/routing possible
- Modular concept, buy as you grow
- Bi-directional traffic on the same fiber

7.2 3R Specifications

Optical filtering and insertion losses will be the same as described for the 16-channel system in section 3.1. of this user manual. For a detailed description of the MR-TR and the SDI-TR cards, we refer to their respective user manuals. We give a brief description of their specifications here:

Parameter	MR-TR	SDI-TR
Optical output power	0 dBm	0 dBm
Wavelength (see ch. 6.5)	Acc. to ITU-T G.694.1	Acc. to ITU-T G.694.1
Input wavelength range	1200-1620nm	1200-1620nm
Maximum bit rate:	1485 Mbps	622 Mbps
Broadcast bit rates (reclocked):	19.4-1485 Mbps	19.4-540 Mbps
Telecom bit rates:	155.52, 622.08 Mbps	155.52, 622.08 Mbps
Gigabit Ethernet support:	Yes	No
Reclocker bypass for other signals, up to max bit rate(*)	Yes	Yes
Power consumption	5W typ,	5W typ

(*) Call your local dealer for assistance in systems design by discussing your signal transport needs. Signals like MADI, Fibre Channel and others can be transported with this product feature enabled.

The optical budget between 3R frames, will depend on the number of channels. The following insertion losses must be subtracted from the optical power budgets (difference of transmitter output power and receiver sensitivity):

Insertion loss, all optical filters included

4-channel system	Max. 6dB per mux/demux pair
8-channel system	Max. 8dB per mux/demux pair
12-channel system	Max. 10dB per mux/demux pair incl. R/B split
16-channel system	Max. 10dB per mux/demux pair incl. R/B split

7.3 Frame configuration

The configuration of the optical signal paths through the frame follows the same philosophy that was used in chapter 2 of this user manual. Corresponding wavelengths should always be connected from the optical demultiplexer/multiplexer to the optical ports of MR-TR/SDI-TR. The cascading pattern if more

than four wavelengths are being regenerated is also the same as described in chapter 2. Use the upgrade ports of the optical filters to connect to the next set of wavelengths. Recall that the configuration of the 3R frame(s) is the same as if you put a receiver frame and a transmitter frame back-to-back. It is therefore wise to complete the optical signal paths on the demultiplexer side, before doing the same exercise on the multiplexer side. The upper optical port on the MR-TR/SDI-TR card is the optical output, the lower optical port is the optical receiver.

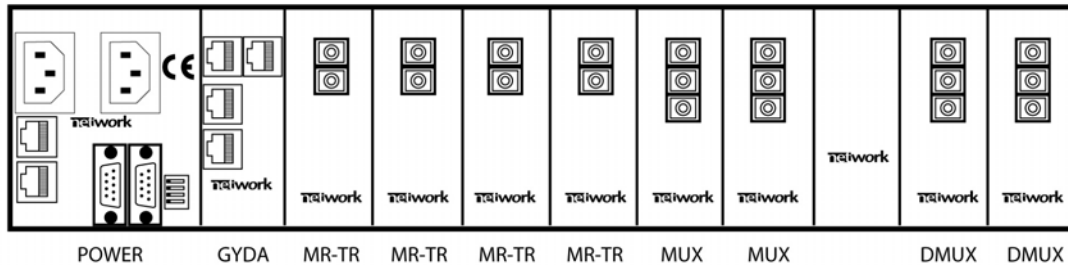


Figure 7.3: Backplane overview of the 3R-2RU flashlink frame fitted with 4 MR-TR cards, for simplicity only the optical ports of the MR-TR cards are shown. The frame is equipped with a GYDA System Controller that allows for remote control and monitoring of the signals over TCP/IP.

For uni-directional signals, all signals should be connected in the same manner, meaning that the connection from the demultiplexer should be to the corresponding optical input of the MR-TR/SDI-TR cards. Each of the optical outputs should likewise be connected to the optical multiplexer.

For a bi-directional system, like the system shown in figure 7.1, the wavelengths running downstream and upstream should be connected to the input and output ports of MR-TR/SDI-TR respectively.

8 Application notes

8.1 3R-regeneration used in a long-haul connection

The block diagram shown in figure 8.1 illustrates the simplicity of the 3R products. In this example, 4 signals are transported over a distance of 215km using, 2 pieces of 3R-2RU-DWDM frames to do the signal regeneration.



Figure 8.1: 3R-regeneration used for a 215km long-haul digital video connection running over optical fiber.

Other application examples can be requested from Network Electronics head quarters.

8.2 ADM-nodes

Add-Drop-Multiplex nodes can be built by combining a digital video router with the flashlink[®] DWDM-system. This can be used together with the 3R DWDM product lines, or the regular DWDM transmitter and receiver frames. An example of a 16-channel ADM-node is shown in figure 8.2.

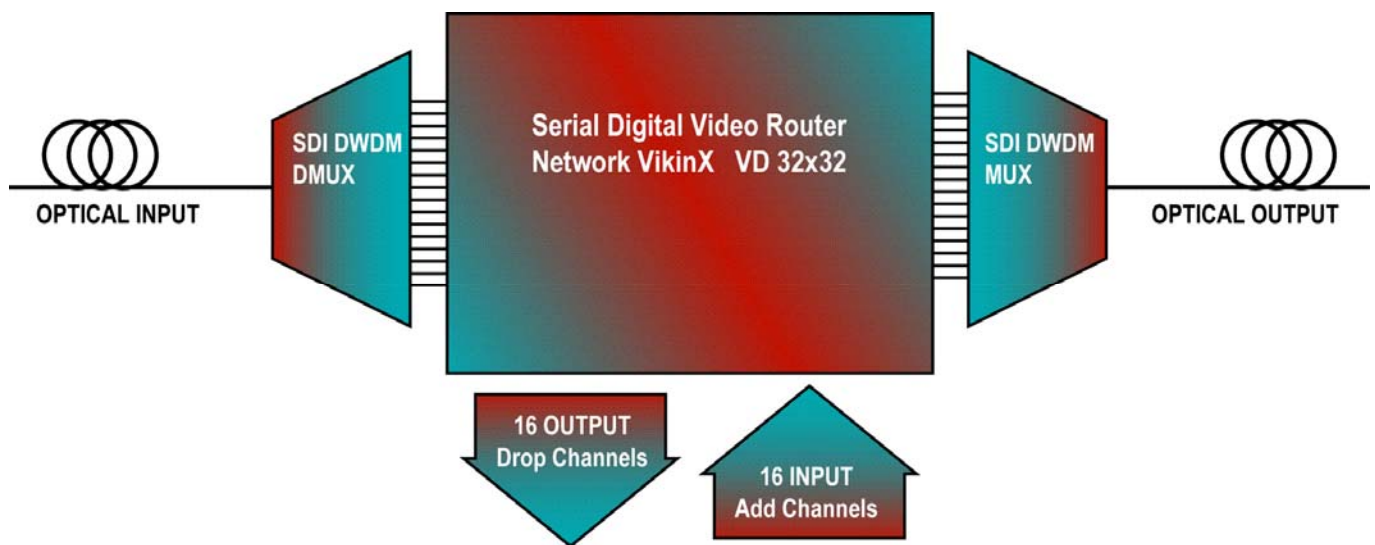


Figure 8.2: Example of a 16-channel ADM-node consisting of a 32x32 digital video router and a 16-channel DWDM-system.

At this node, channels can be dropped from the fiber and other channels can be added to the fiber. To have the maximum flexibility it is essential that the square digital video router has twice the size as the number of channels on the fiber, otherwise it will not be possible to change all the channels on the fiber simultaneously.

This add-drop process is done most cost-efficiently in steps of 4 channels, since each FR-DWDM contains 4 channels.

Troubleshooting

No green light on the power supply LED when electrical power is applied.

Each power supply has a separate on-off switch for the secondary side of the power supply. This is found on the power supply board behind the front panel.

Remove the front panel as described in chapter 5, and make sure that the power switch is down. If power is fed to the sub-rack the LED in front shall be green

Only one of the redundant power supplies has the green LED lit in front.

Remove the front panel and make sure that both power supplies have the power switch down and that electrical power is fed to both power supplies on the back planes. If this does not help, try to swap the positions of the power supplies. If the same power supply still is not lit, it must be replaced. If the power supply in the same position as before the swap still does not have a lit LED, the power supplied to the back plane is faulty.

One channel (wavelength) has significantly less power at the receiver end.

Clean the optical connectors of that particular channel as described in chapter 6. Both the connectors on the receiver side as well as on the transmitter side must be cleaned. Make sure that all connectors are correctly aligned (the white line on top of the SC-connector shall *not* be visible). A bad or dirty connection may introduce an extra 10dB of loss.

One of the channels is not present at the receiver end.

- a) Clean the optical connectors of that channel
- b) The optical fiber might be damaged. Replace the patch cord with another cord of type SC/UPC-SC/UPC single mode fiber.
- c) You may have exceeded the transmission budget of the optical link for that channel. The individual channels have a small variation in optical power causing the weakest channel to disappear first when the transmission budget is at its limit. Please recalculate your transmission budget and compare to the specifications of the system.

No electrical SDI signal on the receiver side.

If all module LED's on the front panel are green, check that the receiving signal cable is connected to one of the two "digital outputs" and not to the "digital input" connection.

If one of the LED's is red, please refer to the user manual of the module.

No contact with the Gyda system controller on the LAN.

Check that the operator's computer is connected to the LAN.

The ethernet cable pin layout shall be one-to-one if Gyda is connected to a hub or switch. If a computer is connected directly to Gyda, an ethernet cable with twisted pinning must be used.

Go through the enclosed "Gyda Quick Start Guide" to install the module properly.

The Gyda system controller is not displaying all sub-racks connected.

Make sure that all sub-rack frames have unique DIP-switch addresses.

The Gyda system controller is adding non-occurring events in the log-file.

Control that the RS-422 bus is terminated with the 110Ω- terminator plug enclosed in the package.

Other requests for assistance:

Network Electronics ASA
Thorøya
3230 Sandefjord, Norway
Phone: +47 33 48 99 99
Fax: +47 33 48 99 98
e-mail: support@network-electronics.com
www.network-electronics.com
Direct Service Phone: +47 90 60 99 99

Declaration of conformity with CE

This apparatus meets the requirements of EN 55103-1 (November 1996) with regard to emissions, and EN 55103-2 (November 1996) with regard to immunity; it thereby complies with the Electromagnetic Compatibility Directive 89/336/EEC.

General environmental requirements for flashlink® equipment

1. The equipment will meet the guaranteed performance specification under the following environmental conditions:

- Operating room temperature range 0°C to 40°C
- Operating relative humidity range up to 90% (non-condensing)

2. Electromagnetic compatibility conditions:

- Emissions EN 55103-1 (Directive 89/336/EEC)
- Immunity EN 55103-2 (Directive 89/336/EEC)

Product Warranty

The warranty terms and conditions for the product(s) covered by this manual follow the General Sales Conditions by Network Electronics ASA. These conditions are available on the company web site of Network Electronics ASA:

www.network-electronics.com

Materials declaration and recycling information

Materials declaration

For product sold into China after 1st March 2007, we comply with the “Administrative Measure on the Control of Pollution by Electronic Information Products”. In the first stage of this legislation, content of six hazardous materials has to be declared. The table below shows the required information.

組成名稱 Part Name	Toxic or hazardous substances and elements					
	鉛 Lead (Pb)	汞 Mercury (Hg)	鎘 Cadmium (Cd)	六价铬 Hexavalent Chromium (Cr(VI))	多溴联苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
FR-DWDM	X	O	O	O	O	O
O: Indicates that this toxic or hazardous substance contained in all of the homogeneous materials for this part is below the limit requirement in SJ/T11363-2006.						
X: Indicates that this toxic or hazardous substance contained in at least one of the homogeneous materials used for this part is above the limit requirement in SJ/T11363-2006.						

Environmentally-friendly use period

The manual must include a statement of the “environmentally friendly use period”. This is defined as the period of normal use before any hazardous material is released to the environment. The guidance on how the EFUP is to be calculated is not finalised at the time of writing. See

<http://www.aeanet.org/GovernmentAffairs/qfLeOpAaZXaMxqGjSFbEidSdPNtpT.pdf> for an unofficial translation of the draft guidance. For our own products, Network Electronics has chosen to use the 50 year figure recommended in this draft regulation.

Network Electronics suggests the following statement on An “Environmentally Friendly Use Period” (EFUP) setting out normal use:

EFUP is the time the product can be used in normal service life without leaking the hazardous materials. We expect the normal use environment to be in an equipment room at controlled temperature range (0°C - 40°C) with moderate humidity (< 90%, non-condensing) and clean air, not subject to vibration or shock.

Further, a statement on any hazardous material content, for instance, for a product that uses some tin/lead solders:

Where a product contains potentially hazardous materials, this is indicated on the product by the appropriate symbol containing the EFUP. The hazardous material content is limited to lead (Pb) in some solders. This is extremely stable in normal use and the EFUP is taken as 50 years, by comparison with the EFUP given for Digital Exchange/Switching Platform in equipment in Appendix A of “General Rule of Environment-Friendly Use Period of Electronic Information Products”. This is indicated by the product marking:



It is assumed that while the product is in normal use, any batteries associated with real-time clocks or battery-backed RAM will be replaced at the regular intervals.

The EFUP relates only to the environmental impact of the product in normal use, it does not imply that the product will continue to be supported for 50 years.

Recycling information

Network Electronics provides assistance to customers and recyclers through our web site <http://www.network-electronics.com>. Please contact Network Electronics' Customer Support for assistance with recycling if this site does not show the information you require.

Where it is not possible to return the product to Network Electronics or its agents for recycling, the following general information may be of assistance:

Before attempting disassembly, ensure the product is completely disconnected from power and signal connections.

All major parts are marked or labelled to show their material content.

Depending on the date of manufacture, this product may contain lead in solder.

Some circuit boards may contain battery-backed memory devices.